Teaching and Examination Scheme for B.Tech in Electronic Engineering

Program Name: Electronic Engineering

Program Code: B.Tech With Effect from Academic Year: 2024-2025

Duration of Program: 8 Semesters

Duration: 16 Weeks

Semester: First

6	Correct Title	Cub as do	r	Feach Schei	ing ne	Crealit						Exa S	minatio cheme	n						Grand
Sr. No	Course Thie	Sub.code				Crean (L+T		-	Th	eory]	Practica	ıl	_		Total
			L	Т	Р	+ P)	Paper	ES	SE	P	A	То	tal	ES	E	P	4	То	tal	
							Hrs.	Max	Min	Max	Min	Max	Min	Max	Min	Max	Min	Max	Min	
1	Engineering Physics	1LP01	2	-	2	3	3	60	24	40	00	100	40	25	10	25	10	50	20	150
2	Engineering Drawing	1LP02	1	-	4	3	3	25	10	25	00	50	20	50	20	50	20	100	40	150
3	Engineering Mathematics-I	1L03	3	1	-	4	3	60	24	40	00	100	40	-	-	-	-	-	-	100
4	Electrical Engineering	1LP04	3	-	2	4	3	60	24	40	00	100	40	25	10	25	10	50	20	150
5	Python Programming	1LP05	2	0	2	3	3	60	24	40	00	100	40	25	10	25	10	50	20	150
6	Engineering chemistry	1L06	3	0	-	3	3	60	24	40	00	100	40	-	-	-	-	-	-	100
		Total	14	1	10	20	-	325	-	225	-	550	-	125	-	125	-	250	-	800

Student Contact Hours Per Week: 40 Hrs.

Medium of Instruction: English

Theory and practical periods of 60 minutes each. Total Marks: 800

Abbreviations: ESE- End Semester Exam, PA- Progressive Assessment, L - Lectures, T - Tutorial, P - Practical

• Under the theory PA, out of 40 marks, 10 marks are for micro-project assessment/assignment to facilitate integration of COs and the remaining 20 marks is the average of 2 tests to be conducted during the semester for theassessment of the cognitive domain LOs required for the attainment of the COs.

Teaching and Examination Scheme for B.Tech in Electronic Engineering

Program Name: Electronic Engineering

Program Code: B.Tech With Effect from Academic Year: 2024-2025

Duration of Program: 8 Semesters

Duration: 16 Weeks

Semester: Second

S -		Sub	T S	'eachi Schem	ng Ie	Credit						Exa S	minatio cheme	n						Grand
Sr. No	Course Title	Sub. code				(L+T+P			The	eory						Prace	tical			Totai
110		coue	L	Т	Р)	Paper Hrs.	ES	SE .	P.	A	To l	ta	ES	SE	P	A	То	tal	
								Max	Min	Max	Min	Max	Min	Max	Min	Max	Min	Max	Min	
1	Engineering mathematics-II	2L07	3	1	-	4	3	60	24	40	00	100	40	-	-	-	-	-	-	100
2	Energy and Environment Engineering	2L08	2	1	-	3	3	60	24	40	00	100	40	-	-	-	-	-	-	100
3	Sports and Yoga	2LP09	-	1	4	3	3	25	10	25	00	50	20	50	20	50	20	100	40	150
4	Electronic devices and Circuits	2LP10	3	-	2	4	3	60	24	40	00	100	40	50	20	50	20	100	40	150
5	Workshop technology	2LP11	-	1	4	3	3	25	10	25	00	50	20	50	20	50	20	100	40	150
6	Communication skills	2LP12	1	1	2	3	3	60	24	40	00	100	40	25	10	25	10	50	20	150
		Total	9	5	10	20	-	290	-	210	-	500	-	75	-	75	-	250	-	800

Student Contact Hours Per Week: 40 Hrs.

Medium of Instruction: English

Theory and practical periods of 60 minutes each. Total Marks: 800

Abbreviations: ESE- End Semester Exam, PA- Progressive Assessment, L - Lectures, T - Tutorial, P - Practical

• Under the theory PA, out of 40 marks, 10 marks are for micro-project assessment/assignment to facilitate integration of COs and the remaining 20 marks is the average of 2 tests to be conducted during the semester for theassessment of the cognitive domain LOs required for the attainment of the COs.

Teaching and Examination Scheme for B.Tech in Electronic Engineering

Program Name: Electronic Engineering

Program Code: B.Tech With Effect from Academic Year: 2024-2025

Duration of Program: 8 Semesters

Duration: 16 Weeks

Semester: Third

6	Comment Title	Teach Schei	ning me	Con 14						Exa S	minatio cheme	n						Grand		
Sr. No	Course Title	Sub. code				(L+T+P				Theory	7					Pra	ctical			Total
			L	Т	Р)	Pape	ES	SE	P.	A	То	tal	ES	E	P	A	То	tal	
							r Hrs.	Max	Min	Max	Min	Max	Min	Max	Min	Max	Min	Max	Min	
1	Engineering mathematics-III	3L13	3	1	-	4	3	60	24	40	00	100	40	-	-	-	-	-	-	100
2	C/C++ Programming	3LP14	2	1	2	4	3	60	24	40	00	100	40	25	10	25	10	50	20	150
3	Power Electronics	3L15	2	-	-	2	3	60	24	40	00	100	40	-	-	-	-	-	-	100
4	Electronic measurement and instrumentation	3LP16	2	-	2	3	3	60	24	40	00	100	40	25	10	25	10	50	20	150
5	Digital Logic and Circuits	3LP17	2	1	2	4	3	60	24	40	00	100	40	25	10	25	10	50	20	150
6	Linear Electrical Networks	3L18	2	1	-	3	3	60	24	40	00	100	40	-	-	-	-	-	-	100
		Total	13	4	6	20	-	360	-	240	-	600	-	50	-	50	-	50	-	750

Student Contact Hours Per Week: 40 Hrs. Mediu

Medium of Instruction: English

Theory and practical periods of 60 minutes each. Total Marks: 750

Abbreviations: ESE- End Semester Exam, PA- Progressive Assessment, L - Lectures, T - Tutorial, P - Practical

• Under the theory PA, out of 40 marks, 10 marks are for micro-project assessment/assignment to facilitate integration of COs and the remaining 20 marks is the average of 2 tests to be conducted during the semester for the assessment of the cognitive domain LOs required for the attainment of the COs.

Teaching and Examination Scheme for B.Tech in Electronic Engineering

Program Name: Electronic Engineering

Program Code: B.Tech With Effect from Academic Year: 2024-2025

Duration of Program: 8 Semesters

Duration: 16 Weeks

Semester: Fourth

S		T S	'eachi Schem	ng 1e	Cuadit						Exa S	minatio cheme)n						Grand	
Sr. No	Course Title	Sub.code				(L+T+P				Theor	у					Prac	tical			Totai
110			L	Т	Р)	Pape	ES	SE	P	A	То	tal	ES	SE	P	A	To	otal	
							r Hrs.	Max	Min	Max	Min	Max	Min	Max	Min	Max	Min	Max	Min	
1	Control System	4L19	3	-	-	3	3	60	24	40	00	100	40	-	-	-	-	-	-	100
2	Electromagnetics and Field Theory	4L20	3	1	-	4	3	60	24	40	00	100	40	-	-	-	-	-	-	100
3	Microprocessor and Microcontroller	4LP21	2	-	2	3	3	60	24	40	00	100	40	25	10	25	10	50	20	150
4	Analog Communication	4LP22	2	-	2	3	3	60	24	40	00	100	40	25	10	25	10	50	20	150
5	Analog Electronics	4LP23	3	-	2	4	3	60	24	40	00	100	40	25	10	25	10	50	20	150
6	Signals and Systems	4L24	3	-	-	3	3	60	24	40	00	100	40	-	-	-	-	-	-	100
		Total	16	1	6	20	-	360	-	240	-	600	-	75	-	75	-	150	-	750

Student Contact Hours Per Week: 40 Hrs. Medium of Instruction: English

Theory and practical periods of 60 minutes each. Total Marks: **750**

Abbreviations: ESE- End Semester Exam, PA- Progressive Assessment, L - Lectures, T - Tutorial, P - Practical

• Under the theory PA, out of 40 marks, 10 marks are for micro-project assessment/assignment to facilitate integration of COs and the remaining 20 marks is the average of 2 tests to be conducted during the semester for the assessment of the cognitive domain LOs required for the attainment of the COs.

Teaching and Examination Scheme for B.Tech in Electronic Engineering

Program Name: Electronic Engineering

Program Code: B.Tech With Effect from Academic Year: 2024-2025

Duration of Program: 8 Semesters

Duration: 16 Weeks

Semester: Fifth

S		Ck	T S	'eachi Schem	ng 1e	Credit						Exa S	iminatio Scheme	n						Grand
Sr. No	Course Title	Sub. code				(L+T+P				Theorem	ry					Pr	actical			Total
110			L	Т	Р)	Paper	E	SE	P	A	Τα	otal	ES	SE	P	A	Το	otal	
							Hrs.	Max	Min	Max	Min	Max	Min	Max	Min	Max	Min	Max	Min	
1	Digital Communication	5LP25	2	-	2	3	3	60	24	40	00	100	40	25	10	25	10	50	20	150
2	Transmission Lines and PCB Technology	5LP26	-	1	4	3	3	25	10	25	00	50	20	50	20	50	20	100	40	150
3	Digital signal processing	5LP27	3	-	2	4	3	60	24	40	00	100	40	25	10	25	10	50	20	150
4	Computer Architecture and organization	5L28	2	1	-	3	3	60	24	40	00	100	40	-	-	-	-	-	-	100
5	Artificial intelligence and machine learning	5LP29	2	-	2	3	3	60	24	40	00	100	40	-	-	-	-	-	-	100
6	VLSI Design	5LP30	3	-	2	4	3	60	24	40	00	100	40	25	10	25	10	50	20	150
		Total	10	2	12	20	-	325	-	225	-	550	-	100	-	100	-	200	-	800

Student Contact Hours Per Week: 40 Hrs. N

Medium of Instruction: English

Theory and practical periods of 60 minutes each. Total Marks: 800

Abbreviations: ESE- End Semester Exam, PA- Progressive Assessment, L - Lectures, T - Tutorial, P - Practical

• Under the theory PA, out of 40 marks, 10 marks are for micro-project assessment/assignment to facilitate integration of COs and the remaining 20 marks is the average of 2 tests to be conducted during the semester for theassessment of the cognitive domain LOs required for the attainment of the COs.

Teaching and Examination Scheme for B.Tech in Electronic Engineering

Program Name: Electronic Engineering

Program Code: B.Tech With Effect from Academic Year: 2024-2025

Duration of Program: 8 Semesters

Duration: 16 Weeks

Semester: Sixth

6	Course Title	T S	eachi Schen	ng 1e	Creadit						Exa S	minati cheme	on						Grand	
Sr. No	Course Thie	Sub. code				(L+T+P				Theor	у					Pra	ctical			Totai
110			L	Т	Р)	Paper	ES	SE	P	A	То	tal	ES	SE	P.	A	То	tal	
							Hrs.	Max	Min	Max	Min	Max	Min	Max	Min	Max	Min	Max	Min	
1	SoC Design and Verification	6LP31	3	-	2	4	3	60	24	40	00	100	40	25	10	25	10	50	20	150
2	Electronic product design Using EDA tools	6LP32	2	-	2	3	3	60	24	40	00	100	40	25	10	25	10	50	20	150
3	Embedded systems and IoT	6LP33	2	1	2	4	3	60	24	40	00	100	40	25	10	25	10	50	20	150
4	Computer networks and Security	6L34	2	1	-	3	3	60	24	40	00	100	40	-	-	-	-	-	-	100
5	Mini project lab	6P35	-	-	6	3	3	-	-	-	-	-	-	50	20	50	20	100	40	100
6	Advanced communication/ Wireless Sensor Networks	6L36	3	-	-	3	3	60	24	40	00	100	40	-	-	-	-	-	-	100
	L	Total	12	2	12	20	-	300	-	200	-	500	-	125	-	125	-	250	-	750
Stud	ent Contact Hours Per Week: 40 H	[rs.	Me	dium	of Ins	truction: Eng	glish													

Theory and practical periods of 60 minutes each. Total Marks: **750**

Abbreviations: ESE- End Semester Exam, PA- Progressive Assessment, L - Lectures, T - Tutorial, P - Practical

• Under the theory PA, out of 40 marks, 10 marks are for micro-project assessment/assignment to facilitate integration of COs and the remaining 20 marks is the average of 2 tests to be conducted during the semester for the assessment of the cognitive domain LOs required for the attainment of the COs.

Teaching and Examination Scheme for B.Tech in Electronic Engineering

Program Name: Electronic Engineering

Program Code: B.Tech With Effect from Academic Year: 2024-2025

Duration of Program: 8 Semesters

Duration: 16 Weeks

Semester: Seventh

Sr. No	Course Title	Sub.code	T S	each chei	ning me	Credit (L+T+P			Th	eory		Exa S	minati cheme	on		Practi	cal			Grand Total
			L	Т	Р)	Paper	ES	SE	P.	A	То	tal	ES	SE	P	A	То	tal	
							Hrs.	Max	Min	Max	Min	Max	Min	Max	Min	Max	Min	Max	Min	
1	MOOC Courses (Elective 1)	7L37	-	-	-	4	-	-	-	-	-	-	-	-	-	-	-	-	-	
2	MOOC Courses (Elective 2)	7L38	-	-	-	3	-	-	-	-	-	-	-	-	-	-	-	-	-	
3	Industrial Visit, Employability skill	7LP39	-	2	2	3	-	-	-	-	-	-	-	50	20	50	20	100	40	100
4	Dissertation Phase-I	7LP40	-	-	20	10	-	-	-	-	-	-	-	50	20	50	20	100	40	100
		Total	-	-	-	20	-	-	-	-	-	-	-	-	-	-	-	-	-	-
Sti	Ident Contact Hours Per Week: 40 Hrs.	Medium of In	struc	ction	: En	glish														

Student Contact Hours Per Week: 40 Hrs.

Theory and practical periods of 60 minutes each. Total Marks: -

Abbreviations: ESE- End Semester Exam, PA- Progressive Assessment, L - Lectures, T - Tutorial, P - Practical

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S1. No.	Electives	MOOC Course	Duration	Credit	Offering Platform/Offering Organization
1	моос	Introduction to Industry 4.0 and Industrial Internet of Things	12 Weeks	4	NPTEL
3	courses for Elective	Introduction to Machine Learning	12 Weeks	4	NPTEL
4	1	Robotics: Basics and Selected Advanced Concepts	12 Weeks	4	NPTEL
5		Product design and Manufacturing	12 Weeks	4	NPTEL
6		ARM based SoC Design	65 Hours	3	NIELIT Calicut
8	MOOC courses	FPGA Architecture and Programming	65 Hours	3	NIELIT Calicut
9	for Elective 2	Fundamentals of VLSI Verification	65 Hours	3	NIELIT Calicut
10		Industrial Electronic Product Design	65 Hours	3	NIELIT Calicut

List of MOOC Courses (Electives)

National Institute of Electronics & Information Technology, Aurangabad																				
		Teachin	g an	d Ex	kamiı	nation Sche	eme for]	B.Tech	in Elec	etronic	Engin	eering								
Pro	gram Name: Electronic Engineering																			
Pro	gram Code: B.Tech With Effect from Aca	demic Year: 202	24-20)25																
Dur	ation of Program: 8 Semesters							Dura	tion: 1	6 Weel	KS									
Sem	ester: Eighth																			
q			T S	'eacl Sche	ning me							Exa S	minati cheme	on						Grand
Sr. No	Course Title	Sub.code				Credit (L+T+P				Theory	7					Pra	actical			Total
L T P) Pape ESE PA Total ESE PA Total																				
							r Hrs.	Max	Min	Max	Min	Max	Min	Max	Min	Max	Min	Max	Min	
1	Dissertation Phase-II	8P41	-	-	40	20	-	-	-	-	-	-	-	50	20	50	20	100	40	100
	Total	-	-	-	40	20	-	-	-	-	-	-	-	-	-	-	-	-	-	-
Stu Th Ab • Un con	Total - - 40 20 - </td																			

Course title:	ENINEERING PHYSICS	Sub code	1LP01								
		Structure	L	Т	P	С					
			2	0	2	3					
Course Objective:	• To equip the students with an under	standing of the "Scientific	e Method	ls"so tl	hat the	y					
	can use the training beneficially in t	heir higher pursuits.		1	1						
	• This course gives a balance account some of recent developments in Engineering applications in different	this area best suited to this area best suited to t branches.	the	aswei	1 as						
Course Outcome:	• The student will be able to underst on lasers and optical fibres.	and many modern device	s andtecl	nnolog	ies ba	sed					
	• Student can also appreciate variou engineering applications and devic	s material properties whi es.	ch are us	sedin							
	• Master fundamental principles of p	hysics applicable to engir	neering.								
	• Apply physics concepts to solve co	mplex engineering proble	ems.								
	• Develop proficiency in experiment	al techniques and data and	alysis.								
	• Integrate physics knowledge across	s engineering disciplines f	for proble	em-sol	ving.						
	• Enhance communication and teams engineering projects.	work skills for effective co	ollaborat	ion in							
Content		No. of hours	ESI	E Mar	ks (%)					
Module 1: Interfer	ence and Diffraction:	6	16								
Interference in thin a Fabry-Perot interference diffraction grating, of power of grating.	film of uniform thickness and non-uniform thic rometer. Fresnel and Fraunhofer diffraction, determination of wavelength using plane diffrac	kness, Newton's rings, M Fraunhofer diffraction a ction grating, dispersive p	ichel son t circular ower of §	's inter apert grating	rferom ture, p , resol	ieter, plane lving					
Module 2: Electros	tatics:	6	16								
Gauss's law and its a Work and Energy, C Coordinate Systems Energy in dielectric:	pplications, Divergence and Curl of Electrostati conductors, Capacitors, Laplace's equation, Meth , Dielectrics, Polarization, Bound Charges, Elec s, Forces on dielectrics.	c fields, Electrostatic Pote hod of images, Boundary tric displacement, Bounda	ential, Bo value pro ary condi	undary blems tions ir	v cond in Car n diele	itions, tesian ctrics,					
Module 3: Magnet	ostatics	6	16								
Lorentz force, Bio fields, Magnetic v	t-Savart and Ampere's laws and their appli ector Potential, Force and torque on a mag	cations, Divergence and netic dipole,	d Curl o	f Mag	neto	static					
Module 4: Dielect	rics materials:	8	18								
Magnetic material materials, Ferroma materials. Dielectric polar dielectrics, po	s, Magnetization, Bound currents, Boundar gnetic materials, origin of magnetization, Ty cs-Introduction, dielectric constant, polarization larization-an atomic view, types of polarization	ry conditions. Diamagne pes of magnetic materia h, induced dipoles, permat	tic mater ls-hard 1 nent dipo	ials, Pa nateria bles,po	arama ils an lar ano	gnetic d soft d non-					
Module 5: Classi	cal Mechanics	6	16								
Review of Newtoni Principles. Collision forces, rigid bossy s	nan Mechanics in rectilinear coordinate system n problems and centre of mass frame. Rotatio ystems.	m, motion in plane polar n about fixed axis. Non-	coordina inertial f	ates. C rames	onser and p	vation seudo					
Module 6: Quantu	m Mechanics/ Physics:	8	18								
Two-slit experiment. Dual nature of light; Compton Effect; De-Broglie hypothesis; Davisson-Germer Experiment; Phase and group velocities; Uncertainty principle; Wave-function; Schrodinger wave equation; Particle in a finite and infinite potential well; Tunnel effect. Superposition Principle, Continuity Equation for probability density; Normalization . Expectation values .Eigen values and eigen functions Stationary states, Bound states, Applications in one dimension: Particle in a box, 1-D Finite Potential well, Harmonic oscillator. Reference Books:											
1) Fiber optic	Communication-D.C.Agarwal. Wheeler Public	cation, New Delhi									

- 2) Solid state electronic devices-Streetman, Prentice Hall India, New Delhi
- 3) Electronic devices and circuits-Allen Mottershade, Prentice Hall India, New Delhi
- 4) Fiber optic communication-Keiser. Mc Graw Hill Publication
- 5) A course in Electrical Engineering Materials S.P.Seth, P.V.Gupta, Dhanpat Rai Publication, New Delhi.
- 6) Engineering physics-Gaur and Gupta, S.Chand Publication
- 7) Engineering physics-Avadhanalu and Kshirsagar, S.Chand Publication

List of Experiments:

- 1) Determination of radius of curvature of Plano- convex lens by Newton's ring
- 2) Determination of wavelength by diffraction grating.
- 3) Study of CRO (amplitude, frequency, phase measurement).
- 4) Experiments on electromagnetic induction and electromagnetic braking;
- 5) LC circuit and LCR circuit;
- 6) Resonance phenomena in LCR circuits;
- 7) Magnetic field from Helmholtz coil;
- 8) Measurement of Lorentz force in a vacuum tube.
- 9) To study different types of Optical fibres.

Course title:	ENGINEERING	Sub 1LP02									
	DRAWING	Struct	T	Т	р	C					
		ure	L		1	C					
			1	0	4	3					
Course Objective:	• To impart and include proper understanding	of the the	eory of	projec	tion.						
	• Improve the visualization skills.										
	• To enable the students with various concepts standards related to working drawing in order	like dim r to beco	ensioni me pro	ing, co fession	nvention ally eff	ns and ïcient.					
	• To impart the knowledge on understanding	and draw	ing of	simple	•						
	residential/ office building.										
Course Outcome:	 Develop proficiency in reading and inter diagrams. 	preting e	enginee	ering d	lrawing	s and					
	 Acquire skills in creating detailed drawings and systems. 	of electr	onic c	ompon	ents, ci	rcuits,					
	 Learn industry-standard drafting technique drawings. 	es and	conver	ntions	for tec	hnical					
	• Gain knowledge of CAD (Computer-Aided) drafting and modeling.	Design) s	oftwar	e tools	for elec	etronic					
	• Enhance visualization and spatial reasoning design and communication.	g abilities	s esser	ntial fo	r engin	eering					
Content		No. of l	ours.	ESE	Marks	(%)					
Module 1 Introduction to en	ngineering drawing:	8		20							
Principles of engineering gra	phics and their significance – drawing instruments	and their	r use –	conver	ntions in	n drawing					
- lettering - BIS convention	s. Dimensioning rules, geometrical construction. C	urves use	ed in er	ngineer	ing prac	ctice and					
their constructions: Conic Se	ections, Special Curves-Cycloids, Epicycloids, Hyp	pocycloid	s.								
Module 2: Projections of S	traight Lines:	8		20							

Projections of points in four quadrants, projections of points in reference plane, line parallel to both the plane, line parallel to one plane and perpendicular to the other, line inclined to one plane and parallel to the other, line inclined to both the reference planes, traces of line, use of traces of line in obtaining projections (all four quadrants should be considered).

Module 3: Projections of planes and solids	8	20

Projections of regular planes, inclined to both planes. Projections of regular solids inclined to both planes. Introduction to solids: prisms, pyramid, cylinder, cone, cube, tetrahedron, sphere, projections of above solids with axis inclined to one plane, projections of above solids with axis inclined to both the planes, projection of composite solids (different arrangement of spheres with above solids).

8

8

20

20

Module 4: Development of Surfaces:

Development of surfaces of right, regular solids – development of prisms, cylinders, pyramids, cones and their parts

Module 5: Orthographic Projections & Isometric views:

Principles of orthographic projections – conventions – first and third angle projections. Projections of points and lines inclined to both the planes. Orthographic projections of different machine parts, sectional orthographic projections. Introduction to pictorial views, isometric projections and isometric views (Isometric and non-isometric planes).

Reference Books:

- 1) Bhatt N. D., Panchal V. M., "Engineering Drawing", Charotar Publishing House.
- 2) Dhabhade M. L., "Engineering Graphics", Vol.-I and Vol.-II, Vision Publications, Pune.
- 3) Mathur, Laxminarayan, "Elements of Engineering Drawing", Jain Publications, New Delhi.

List of Experiments:

- 1) Introduction to BIS SP 46 1988.
- 2) Explanation of various drawing instruments, symbols, RF, Dimensioning, etc.
- 3) Conversion of pictorial views to orthographic / profile views.
- 4) Projection of points and lines.
- 5) Projections of planes.
- 6) Projections of lines and planes using Auxiliary planes.
- 7) Projections of solids.
- 8) Section and development of solids.
- 9) Intersection of solids.
- 10) Isometric views.
- 11) Practice of scales, Representative Factor and dimensioning on some practical exemplaryfigure.

Course title:	ENGINEERING METHAMATICS-I	Sub code	1L03			
		Structure	L	Т	Р	C
		1	3	1	0	4
Course Objective:	• To expose student to understand the calculus, Infinite series and Matrix	• To expose student to understand the basic importance of Differential calculus, Integral calculus, Infinite series and Matrix theory in science and engineering.				tegral
Course Outcome:	 The terminal objectives of the cour learning and evaluation activities, a problems by applying the fundamen Develop a strong understanding of Gain proficiency in differential equi Apply mathematical methods to an 	he terminal objectives of the course are that, on successful completion of teaching earning and evaluation activities, a student would be able to identify and analyse the roblems by applying the fundamental principles of engineering mathematics. Develop a strong understanding of calculus and its applications in engineering. Data proficiency in differential equations and their relevance to engineering systems apply mathematical methods to analyze and model engineering phenomena			ching- se the tems.	
	• Acquire problem-solving skills e	ssential for advanced	engine	ering	courses	s and

	practical applications.				
Contents		No. of hours	ESE Marks (%)		
Module 1: Differential Calo	culus:	8	20		
Functions of single variable:	Limit, continuity and differentiability. N	Iean value theorems: Ro	olle's theorem, Lagrange's		
theorem, Cauchy's theorem,	Taylor's theorem with remainders, inde	eterminate forms, curvat	ture, curve tracing.		
Module 2: Determinants:		8	20		
Determinant of a matrix of or	rder one, order two, order three. Properti	ies of determinant, area	of triangle, minors and co-		
factors, adjoint and inverse o	f a matrix,				
Module 3: Integral Calculu	s:	8	20		
length, volumes and surface under integral sign.	of solids of revolutions, Improper inte	egrals: Beta and Gamma	a functions, differentiation		
Module 4: Sequence and Se	eries	8	20		
Sequences, Infinite series of a convergence, improper integ radius of convergence.	real and complex numbers, Cauchy criter grals, improper integrals depending on	ion, tests of convergence aparameter, uniform co	e, absolute and conditional onvergence, power series,		
Module 5: Matrices:		8	20		
System of linear equations, Augmented matrix, Existence and uniqueness of solution, Gauss elimination method, Elementary row operations, LU decomposition, Row-equivalent systems, Row echelon form, Rank of a matrix, Linear dependence, Consistency of a linear system, Linear combination of solutions, General solution, Types of matrices and their properties, Eigenvalues, Eigen vectors, Eigenvalue problems, Cayley- Hamilton theorem, Similarity of matrices, Diagonalisation, Quadratic form, Reduction to canonical form Reference Books:					
1) Kreyszig, E., Advanced Engineering Mathematics, John Wiley & Sons					
2) Piskunov, N., Differential and Integral calculus, Mir publishers Moscow (Vol. 1, Vol. 2)					
3) Thomas, G.B. and Finn	ey, R.L, Calculus and Analytic Geometr	ry, Addison Wesley Lon	gman		
4) Michael D. Greenberg,	4) Michael D. Greenberg, Advanced Engineering Mathematics, Pearson Education Pvt. Ltd				

5) Jain R.K., Iyengar S.R.K, Advanced Engineering Mathematics, Narosa Publishers

ELECTRICAL ENGINEERING	Sub code		04		
	Structure	L	Т	Р	C
		3	0	2	4
 To enable the students, understand Engineering. To impart knowledge for understand transformers, generators, motors etc 	the basic ideas an ding the details of el	d princip lectrical j	les of	Electr	ical
 Acquire the knowledge about circu Theorems. Analysis of Single Phase AC Circuit determining the power in these circuit Understand the different methods for Acquire knowledge about the constru- of operation of Transformers. Acquire the knowledge of fundament 	it analysis by apply s, the representation its measurement of va actional details, loss tals, construction de	ying KVI n of alterr rious elec ces, paran ctails, wor	C KCL nating o ctrical neters, rking	and r quantit quantit and pr	network ies, and ies. inciples
	 ELECTRICAL ENGINEERING To enable the students, understand Engineering. To impart knowledge for understand transformers, generators, motors etc Acquire the knowledge about circu Theorems. Analysis of Single Phase AC Circuit determining the power in these circuit Understand the different methods for Acquire knowledge about the constru- of operation of Transformers. Acquire the knowledge of fundament 	ELECTRICAL ENGINEERING Sub code Structure Structure • To enable the students, understand the basic ideas an Engineering. • To impart knowledge for understanding the details of et transformers, generators, motors etc. • Acquire the knowledge about circuit analysis by apply Theorems. • Analysis of Single Phase AC Circuits, the representation determining the power in these circuits • Understand the different methods for measurement of va • Acquire knowledge about the constructional details, loss of operation of Transformers. • Acquire the knowledge of fundamentals construction details	ELECTRICAL ENGINEERING Sub code 1LP Structure L 3 3 • To enable the students, understand the basic ideas and princip Engineering. 3 • To impart knowledge for understanding the details of electrical p transformers, generators, motors etc. 6 • Acquire the knowledge about circuit analysis by applying KVI Theorems. 9 • Analysis of Single Phase AC Circuits, the representation of alterr determining the power in these circuits 9 • Understand the different methods for measurement of various election of operation of Transformers. 9 • Acquire knowledge about the constructional details, losses, param of operation of Transformers. 9	ELECTRICAL ENGINEERING Sub code 1LP04 Structure L T 3 0 • To enable the students, understand the basic ideas and principles of Engineering. 3 0 • To impart knowledge for understanding the details of electrical powers transformers, generators, motors etc. • Acquire the knowledge about circuit analysis by applying KVL KCL Theorems. • Analysis of Single Phase AC Circuits, the representation of alternating of determining the power in these circuits • Understand the different methods for measurement of various electrical • Acquire knowledge about the constructional details, losses, parameters, of operation of Transformers. • Acquire the knowledge of fundamentals construction details working	ELECTRICAL ENGINEERING Sub code 1LP04 Structure L T P 3 0 2 • To enable the students, understand the basic ideas and principles of Electric Engineering. • To impart knowledge for understanding the details of electrical powersystems transformers, generators, motors etc. • Acquire the knowledge about circuit analysis by applying KVL KCL and n Theorems. • Analysis of Single Phase AC Circuits, the representation of alternating quantit determining the power in these circuits • Understand the different methods for measurement of various electrical quantit • Acquire knowledge about the constructional details, losses, parameters, and pr of operation of Transformers. • Acquire the knowledge of fundamentals construction details working

No. of hours	ESE Marks (%)
8	20
circuit theorems; Electr prosition Theorem, The Definition, Characteristic	o-magnetism, Faraday's & venin's Theorem, Norton's cs of Practical Source, and ons for Composite Magnetic
8	20
Behaviour with Sinu ower Factor, Principle of em	soidal Excitation, Phasor Generation of Single Phase
8	20
minal voltage enumerati and its significance, torq C motor; 8	ng the brush drop and drop ue equation; Types of D.C.
ircuit, Open Circuit & S	a Condition Transformer on Short Circuit Test, Voltage
8	20
droelectric, Thermal-station.	team, diesel, gas, nuclear
Electrical Engineering, atory Course in Electric	PrenticeHall India calEngineering", Chand S.,
ts.	
	No. of hours 8 circuit theorems; Electr rposition Theorem, The Definition, Characteristic rcuits. Simple Calculation 8 Behaviour with Sinutower Factor, Principle of sm 8 ator and a motor; Types minal voltage enumerati and its significance, torg C motor; 8 ansformer under No Load ircuit, Open Circuit & S ation. Sources of Elect droelectric, Thermal-st tion. Electrical Engineering, atory Course in Electric ts.

Course Title:	Python Programming	Sub code:	1LP0	5		
		Structure:	L	Τ	Р	C
			2	0	2	3
Course Objective:	 To equip students with the necessary procomputational problems and develop soft To enhance students' problem-solving all analyze, design, and implement solution and data analytics. 	ogramming skills and profic ftware applications effectiv pilities by applying Python s across various domains in	ciency in l ely. programm ncluding e	Python ning con	to solve ncepts t ing, sci	ence,
Course Outcome:	 Understand Python syntax and use of Pymanipulate program by using core data strings handling methods. Develop, run Able to understand Data Wrangling. Maarrays, pandas series and data frames. Petransformation, reshaping, pivoting and Able to understand Data Aggregation, Gscrapping. Design the web Application v Explore the use Matplot lib package for techniques for plotting graphs. Compreh paradigm, Select appropriate data visual Explore the use of python programing for the paradigm. 	thon flow control and Func- structures like lists, sets, did and manipulate python pro- nipulate one-dimensional a erform Data Wrangling, dat merging. roup Operations, Time seri with the help of python pro- Data Visualization in pytho end the importance of the e- ization technique for given or IOT system. Installing O	ctions. De ctionaries, grams usin nd multi-o ta loading. es and vas gramming on and imp explorator data. S and Des	velop, r tuples ng file c dimensi , cleanin rious py for IO plement y data a igning	un and and use operatio onal Nu ng, /thon w Γ applic t the dif inalysis System	of ns. umpy eb cation. ferent s using
Content	Raspberry pi. Implement Various IoT sy	No. of hours	nming and ESE	l raspbe Marks	erry p1. 5 (%)	
Module 1: Introdu	ction to Python		8		20)
Displaying Output Calculations, Opera if, if-else, if-elif-els Repetition Structure Loops. Data types	with the Print Function, Comments, Variable tors. Type conversions, Expressions, More about e Statements, Nested Decision Structures, Comp es: Introduction, while loop, for loop, Calculatin and Expressions: Strings, Assignment and Co	es, Reading Input from Data Output. Decision S paring Strings, Logical C ng a Running Total, Inp pomments, Numeric Data	the Ke Structures Operators out Valid Types	yboard and B , Boole ation I and C	l, Perf oolean ean Va Loops, haracte	orming Logic: riables. Nested er Sets,
Module 2: Control s	tatements		8		20)
Definite Iteration, F Input and Output, U Calling a Void Fund Variables and Glob Functions in Modul Module 3: Strings a	Formatting Text for Output, Selection, Condition Using Loops to Process Files, Processing Record ection, Designing a Program to Use Functions, Loc pal Constants, Value-Returning Functions-Gener es	al Iteration. File and Ex ls, Exceptions. Function cal Variables, Passing Ar rating Random Numbers	ceptions: s: Introdu guments s, The m	Introduction, to Fun ath Mo	uction Defini ctions, odule, 20	to File ng and Global Storing
Accessing Character String Slicing, Test slicing, Finding Iter Lists, Two-Dimens Recursion: Introduc	rs and Substrings in a String, Strings and Numb ing, Searching, and Manipulating Strings. Text F ins in Lists with the in Operator, List Methods and ional Lists, Tuples Sequences, Tuples. Dictiona tion, Problem Solving with Recursion, Examples	ber System, String Methe iles, Data Encryption, Li I Useful Built-in Functio ries and Sets: Dictionari of Recursive Algorithm	ods, Basi sts, Intro ns, Copy es, Sets, s	c Strin ductior ing Lis Seriali	g Open n to Lis nts, Pro- izing C	rations, sts, List cessing)bjects.
Module 4: – Design	with classes	C	8		2	.0
Classes and Objects Object-Oriented Pro	, Classes and Functions, Classes and Methods, W ogramming: Procedural and Object-Oriented Prog	orking with Instances, In gramming, Classes, techr	heritance	e and P r Desig	olymoi ning C	rphism. Iasses.
Module 5: Graphica	l User Interface		8		2	.0
Behavior of termin resources. GUI Pro Organizing Widgets	al based programs and GUI-based programs, Co gramming: Graphical User Interfaces, Using the s with Frames, Button Widgets and Info Dialog E	oding simple GUI-based e tkinter Module, Displ Boxes, Getting Input with	progran ay text v n Entry V	ns, othe with La Vidget,	er usef abel W Using	ul GUI /idgets, Labels

as Output Fields, Radio Buttons, Check Buttons. Simple Graphics and Image Processing: Overview of Turtle Graphics, Two dimensional Shapes, Colors and RBG System, Image Processing.

Text/Reference Books:	
	1. Mark Lutz, "Learning Python", O'Reilly Media, 5th Edition, 2016.
	2. White, "Hadoop: The Definitive Guide", Third Edition - O'Reilly, 2012.
	3. Brandon Rhodes and John Goerzen, "Foundations of Python Network Programming: The
	Comprehensive Guide to Building Network Applications with Python", Apress, Second Edition, 2016.
List of Experiments:	
	1. Installation of Python, and learning interactively at command prompt and writing simple
	programs.
	2. Learning the conditions and iterations in Python by writing and running simple programs.
	3. Random number generations, and problems based on random numbers.
	4. Handling tuples and exercises based on tuples.
	5. Functions and files
	6. Linear and binary search
	7. Handling tokens
	8. Finding unique and duplicate items of a list.
	9. Matrix addition, multiplications, and unity matrix.
	10. Text processing using python 11. Programs related to python libraries like Numpy, Pandas,
	Scipy etc

Course title:	ENGINEERING CHEMISTRY	Sub code:	1L)6		
		Structure:	L	Т	Р	C
			3	0	0	3
Course Objective:	 To present sound knowledge of chemistry fur role of Applied Chemistry in the field of s scientific reasoning to do the task rationally. To introduce the students to basic princip evaluation, electrochemical power sources, polymer. 	ndamentals, enriching science and engineeri les of electrochemist the importance of con	students to ng. To inc try, cell co rrosion in t	ounder oulcate	rstand habi	the t of and and
Course Outcome:	 Understand the fundamental principles of chemapplications. Apply chemical concepts to analyze and design Gain knowledge of corrosion mechanisms and Explore environmental chemistry and its impli Acquire laboratory skills for conducting chemiengineering contexts. 	nistry and their releva n engineering material methods for prevention cations for sustainable ical experiments and a	nce to engines Is and proce on in engine e engineerin nalyzing re	neerin esses. eering ng pra esults	g mate ctices	rials.
Content		No. of hours	ESE Mar	•ks (%	b)	
Module 1: Atomic a	nd Molecular Structure	6	1	8		
Schrodinger equation. hydrogen atom wave molecules and plots of molecular orbitals of t ions and their magneti	Particle in a box solutions and their applications for conju- functions and the plots of these functions to explore their f the multicentre orbitals. Equations for atomic and molecular butadiene and benzene and aromaticity. Crystal field theory ic properties. Band structure of solids and the role of doping	igated molecules and spatial variations. Mo ar orbitals. Energy lev and the energy level d g on band structures.	nanoparticl lecular orb el diagrams liagrams for	les. Fo itals o s of di r trans	orms of diat atomi ition	of the comic c. Pi- metal
Module 2: Electroch	nemistry	8		18		

Conductivity of electrolyte hydrogen electrode, calome Weston standard cell, rev concentration cell, concent	es- Specific, molar and equivalent conductivity, Nerns el electrode, glass electrode, Electrolytic and galvanic ce rersible and irreversible cells, concentration cell, elect tration cell with and without transference.	t equation for electro lls, cell EMF, its meas rode (hydrogen gas o	de potential, EMF series, surement and applications, electrode) and electrolyte		
Module 3: Intermolecula	ar forces and potential energy surfaces	6	16		
Ionic, dipolar and van Der	Waals interactions. Equations of state of real gases and	d critical phenomena.	Potential energy surfaces		
of H3, H2F and HCN and	trajectories on these surfaces.				
Module 4: Periodic Prop	erties	6	16		
Effective nuclear charge, penetration of orbitals, variations of s, p, d and f orbital energies of atoms in the periodic table, electronic configurations, atomic and ionic sizes, ionization energies, electron affinity and electronegativity, polarizability, oxidation states, coordination numbers and geometries, hard soft acids and bases, molecular geometries.					
Module 5: Solid State		8	16		
Types of solids - close packing of atoms and ions - bcc, fcc structures of rock salt - cesium chloride- spinel -normal and inverse spinel's, Stoichiometric Defect, controlled valency & Chalcogen semiconductors, Non-elemental semiconducting Materials, Preparation of Semiconductors-steps followed during the preparation of highly pure materials and further treatments. Semiconductor Devices-p-n junction diode.					
Module 6: Polymer		6	16		
Nomenclature, functionality, classification, methods of polymerization, mechanism of polymerization, molecular weight determination-Viscometry, light scattering methods. Plastics-Moulding constituents of a plastics and moulding of plastics into articles. Important thermoplastics and thermosetting resins- synthesis & applications of PVA, FLUON, PC, Kevlar, ABS polymer, phenolic & amino resins, epoxy resins and polyurethanes. Conductive polymers.					
Reference Books	 P. C. Jain and M. Jain, Engineering Chemistry, DI 2005. B.R. Puri, L.R. Sharma, M.S. Pathania, Principles Company, 2008. J. D. Lee, Concise Inorganic Chemistry, 5th Edn., S. S. Dara, S. S. Umare, A Text Book of Engineer F.W. Billmayer. Textbook of Polymer Science, 3r A.R. West, Basic Solid State Chemistry, 2nd edition 	hanpat Rai Publishing of Physical Chemistr Chapman and Hall, I ing Chemistry, S. Cha d Edn, Wiley. N.Y. 1 on, John Wiley and S	company, New Delhi, ry, Vishal Publishing London, 1996. and Publishing, 2011. 991. ons, 1999.		

Course title:	ENGINEERING MATHEMATICS-II	Sub code:	2L(07		
		Structure:	L	Т	Р	C
			3	1	0	4
Course Objective:	To provide students with a fundamental u (Differential calculus & Integral calculus), engineering.	nderstanding of importa , Vector calculus and or	nce of 1 linary d	nult	i variable ential equ	calculus ations in
Course Outcome:	 Understand advanced calculus concepts Master probability and statistics principl Learn differential equations of engineeri Apply mathematical tools to model and a 	 Understand advanced calculus concepts and their applications in engineering. Master probability and statistics principles relevant to engineering analysis. Learn differential equations of engineering importance and their solutions. Apply mathematical tools to model and analyze complex engineering systems. 				
Content		No.	of hour	s	ESE Ma	arks (%)
Module 1: Calculus	s of Functions of Several Variables		8		2	20
Limit, continuity an Tangent plane and n	d differentiability of functions of several variables, pormal line. Euler's theorem on homogeneous, function	partial derivatives and the ns, Total differentiation,	eir geor chain ru	netr les,	ical interp Jacobian,	pretation, Taylor's

formula, maxima and minima, Lagrange's method of undetermined multipliers.

Module 2: Multiple Integrals	8	20
Double and triple integrals, change of order of integration, change of variables, application to gravity.	o area,volumes, M	ass, Centre of
Module 3: Vector Calculus	8	20
Scalar and vector fields, gradient of scalar point function, directional derivatives, divergence solenoidal and irrotational motion. Vector integration: line, surface and volume integrals, Gra Gauss divergence theorem (without proof).	e and curl of vec een's theorem, Str	tor point function, oke's theorem and
Module 4: Ordinary Differential Equations	8	20
First order differential equations: Exact equation, Integrating factors, Reducible to exact Bernoulli's form, orthogonal trajectories, Existence and Uniqueness of solutions. Picard's th solution (Statements only). Solutions of second and higher order linear equation with constant and dependence, Method of variation of parameters, Solution of Cauchy's equation, simultant	differential equa eorem, Picard's in nt coefficients, Lin eous linear equation	ations, Linear and teration method of near independence ons.
Module 5: Complex Variable-Differentiation	8	20
Differentiation, Cauchy-Riemann equations, analytic functions, harmonic functions, findin analytic functions (exponential, trigonometric, logarithm) and their properties; Conformal ma their properties. Reference Books	ng harmonic conj ppings, Mobius tr	ugate; elementary ansformations and
 Kreyszig, E., Advanced Engineering Mathematics, John Wile Piskunov, N., Differential and Integral calculus, Mir publisher Thomas, G.B. and Finney, R.L, Calculus and Analytic Geome Longman. Michael D. Greenberg, Advanced Engineering Mathematics, I Jain R.K., Iyengar S.R.K, Advanced Engineering Mathematic 	y & Sons rs Moscow (Vol. 1 etry, AddisonWes Pearson Educatior s, NarosaPublishe	l,Vol. 2) ley hPvt. Ltd rs.

Course title:	ENERGY AND ENVIRONMENTAL ENGINEERING	Sub code	2L08					
	- ·	Structure	L	Т	Р	С		
			2	1	0	3		
Course Objective:	• To provide students with a fundamen environmental impact, fostering awar	tal understanding of ene eness of sustainable pra	ergy syst ctices ar	ems an nd solu	d their tions.			
	• To analyze environmental challenges engineering solutions to mitigate environmental management	arising from energy uti ronmental impacts, pro- nt.	lization a moting a	and exp a holist	plore ic appr	oach to		
Course Outcome:	• Principal renewable energy systems	• Principal renewable energy systems						
	• Explore the environmental impact of types of pollutants.	• Explore the environmental impact of various energy sources and also the effects of different types of pollutants.						
	• An understanding the problems of end	ergy distribution, design	n, plan ai	nd exec	cute			
	• To make a thought in terms of scientific and technological advancement in the sustainable energy greenhouse				he spii	it of a		
	• Understand the relationships between economics of consumerism, etc in an	natural resources, cons environmental context	umption	, popul	ation,			
Content		No. of hours	ES	E Ma	rks (%)		
Module 1: Introduction:		8	20					
Present Energy resour	ces in India and its sustainability - Different type of	conventional Power Pla	int-					
-Energy Demand Sce conventional power ge	nario in India-Advantage and Disadvantage of co eneration.	nventional Power Plan	ts –Con	ventior	nal Vs	Non-		

Module 2: Basics of Solar Energy:	8	20

					
Basics of Solar Energy- Solar Thermal Energy- Solar Photovoltaic- Advantag	es and Disadvantages-	Environmental impacts and			
safety.	1	1			
Module 3: Wind, Biomass, Geothermal conversions and resources:	8	20			
Power and energy from wind turbines- India's wind energy potential- Types of wind turbines- Offshore Wind energy- Environmental benefits and impacts. Biomass resources-Biomass conversion Technologies- Feedstock pre-processing and treatmentmethods- Bioenergy program					
in India-Environmental benefits and impacts.					
Geothermal Energy resources –Ocean Thermal Energy Conversion – Tidal.					
Module 4: Air Pollution and Greenhouse gases :	8	20			
Air pollution- Sources, effects, control, air quality standards, air pollution act, air pollution measurement. Water pollution-Sources and impacts, Soil Pollution-Sources and impacts, disposal of solid waste. Greenhouse gas effect, acid rain. Noise pollution. Pollution aspects of various power plants. Fossilfuels and impacts, Industrial and transport emissions- impacts.					
Module 5: Social Issues related to Environment:	8	20			
From Unsustainable to Sustainable development, Urban problems related to energy, Water conservation, rain water harvesting, watershed management, Resettlement and rehabilitation of people; its problems and concerns. Climate change, global warming, acid rain, ozone layer depletion and Eutrophication, Wasteland reclamation. Consumerism and waste products. Environment Protection Act. Air (Prevention and Control of Pollution) Act. Water (Prevention and control of Pollution) Act, Wildlife Protection Act, Forest Conservation Act. Reference Books:					
1) Boyle, G. 2004. Renewable energy: Power for a sustainable future, Oxford University press.					
2) B H Khan, Non-Conventional Energy Resources-The McGraw –Hill Sec	ond edition.				
3) G. D. Rai, Non-conventional energy sources, Khanna Publishers, New Delhi, 2006.					

 Gilbert M. Masters, Introduction to Environmental Engineering and Science, 2nd Edition, Prentice Hall, 2003.

Course title:	Sports and Yoga	Sub code:	2LP09			
		Structure:	L	Т	P	C
			0	1	4	3
Course Objective:	 To maintain students' menta them to cope up with the stree To create space in the curric sports/games/yoga etc. To introduce a practice orier advanced course may come 	To maintain students' mental and physical wellness upright and develop ability in them to cope up with the stress arising in the life. To create space in the curriculum to nurture the potential of the students in sports/games/yoga etc. To introduce a practice oriented introductory course on the subject. More involved / advanced course may come up in subsequent years of study.				
Course Outcome:	 Enhance physical fitness, sta participation in sports activit Develop teamwork, leadersh group exercises. Cultivate mindfulness, stress practice of yoga. Promote a healthy lifestyle a activity. Understand the importance of health for optimal performant 	amina, and overall well-betties. aip, and communication sign and communication sign and communication sign and selected and balance between acad of sports and yoga in main ace in academic and professional selected and profession and profession and profession academic academic and profession academic academic and profession academic	eing through kills through tion techniqu emic studies ntaining ment essional pursu	regul team es th and p al an its.	ar sports rough bhysic d phy	s and the al sical
Content	1	No. of hours		ESI	E Mar	ks (%)

Module 1: Introduction to Sports Science and Yoga		8	20		
Overview of sports science and its applications in engineering, Intro	duction to yoga, its history, and	benefits, Basic	principles of		
sports training and conditioning, Introduction to various yoga asanas	sports training and conditioning, Introduction to various yoga asanas (poses) and their significance				
Module 2: Anatomy and Physiology in Sports and Yoga		8	20		
Understanding human anatomy and physiology related to sports per	formance, Effects of exercise and	l yoga on variou	us systems of		
the body, Biomechanics of movement in sports and yoga, Yoga anato in asanas	my: Understanding the alignmen	t and engageme	nt of muscles		
Module 3: Sports Training and Techniques	8	20			
Principles of sports training: Strength, endurance, speed, and flex	ibility, Training methodologies	and periodizati	on in sports,		
Techniques for enhancing athletic performance, Introduction to sport	s-specific drills and exercises, A	pplication of yo	ga asanas for		
improving athletic performance and preventing injuries					
Module 4: Sports Psychology and Mindfulness		8	20		
Understanding the psychological aspects of sports performance, Mer	ntal preparation and goal setting i	n sports, Stress	management		
techniques for athletes, Introduction to mindfulness and its applic	ation in sports and engineering	, Incorporating	mindfulness		
practices into daily routine for improved focus and concentration					
Module 5: Applied Sports Science and Yoga in Engineering820					
Integration of sports science principles in engineering design, Biomechanical analysis of sports equipment and technologies, Case					
studies on the application of sports science in engineering projects, Designing ergonomic workspaces and equipment for athletes					
and engineers, Practical sessions combining sports activities, yoga, and engineering projects					

Reference Books

- 1. "Introduction to Sports Science" by Robert Weinberg and Daniel Gould
- 2. "Essentials of Strength Training and Conditioning" by NSCA National Strength & Conditioning Association
- 3. "Biomechanics of Sport and Exercise" by Peter McGinnis
- 4. "Yoga Anatomy" by Leslie Kaminoff and Amy Matthews
- 5. "Anatomy and Physiology for Health Professionals" by Jahangir Moini
- 6. "Sports Training Principles" by Frank Dick
- 7. "The Psychology of Enhancing Human Performance" by Frank L. Gardner and Zella E. Moore
- 8. "Mind Gym: An Athlete's Guide to Inner Excellence" by Gary Mack
- 9. "Mindfulness in Plain English" by Bhante Henepola Gunaratana
- 10. "Engineering Biomechanics: Mechanics and Design Applications in Musculoskeletal Systems" by D. Gordon E. Robertson and Graham E. Caldwell

list of Experiments

- 11. Hands-on practice sessions focusing on various yoga asanas such as Sun Salutation, Warrior poses, and balancing poses.
- 12. Emphasis on correct alignment, breath awareness, and relaxation techniques.
- 13. Practical training sessions in different sports disciplines like cricket, football, volleyball, or athletics.
- 14. Focus on improving specific skills such as batting techniques, dribbling skills, or throwing techniques.
- 15. Conducting fitness assessments including measurements of flexibility, strength, endurance, and cardiovascular fitness using standardized protocols.
- 16. Analysis of fitness test results to identify areas for improvement and design personalized fitness programs.
- 17. Interactive sessions exploring the philosophical principles of yoga such as the Eight Limbs of Yoga, Karma Yoga, and Bhakti Yoga.
- 18. Guided meditation practices to cultivate mindfulness, concentration, and inner peace.
- 19. Practical sessions on sports nutrition focusing on meal planning, hydration strategies, and nutrient timing for optimal performance and recovery.
- 20. Hands-on experience in preparing nutritious meals and snacks tailored to athletes' dietary needs.

Course title:	Electronics Devices and Circuits	Sub code:	2LP10			
		Structure:	L	Т	Р	С
			3	0	2	4
Course Objective:	 This course aims to provide students with a for semiconductor devices, including their operation applications in electronic circuits and systems. Students will gain proficiency in analyzing and them to comprehend the behavior of diodes in knowledge to practical circuit design scenarios. Through this course, students will develop a cobehavior within the context of circuit-level and junctions in the operation of diodes and other deeper insights into electronic device behavior 	undational understar ng principles, charao d designing simple d various configuratio s. omprehensive under alysis. They will exp active semiconducto	nding o cteristi liode c ons and standin lore th r devic	of basic ics, and ircuits, d apply ng of P ne pivol cces, fac	divers enabli this N junc cal role ilitatin	ng tion of PN
Course Outcome:	 Understand the principles and operating chara transistors, and integrated circuits. Analyze and design electronic circuits using v applications. Gain proficiency in device modeling, simulative Explore emerging electronic devices and their Develop troubleshooting skills for diagnosing problems in circuits and systems. 	cteristics of electron arious semiconducto on, and characterizat potential application and rectifying electr	ic devi or devid tion tec 1s in m onic d	ices suc ces for chnique nodern levice-r	ch as di differe es. techno elated	iodes, ent logies.
Content	problems in circuits and systems.	No. of hours	E	ESE M	arks (S	%)
Module 1: Basic Und	erstanding of Semiconductor Devices		8			20
Introduction to Quant Atoms and formation in solids. Semicondu energy levels, intrin	um Theory of Solids: Basic principles of quantum mechan of energy bands, electrical conduction in solids, density of ta ctor in Equilibrium: charge carriers in semiconductors sic and extrinsic semiconductors; charge neutrality, Fe	ics, Schrodinger eq ates functions, bondi s, carrier concentra rmi energy level.	uation ng forc ations,	and its ces and , dopa	applic energy nt ator	cations, y bands ms and
Module 2: Power dev	ices & Switching Devices			8		20
Carrier Transport Pher velocity- electric field Semiconductors: Carrie surface effects.	nomena: Carrier drift, diffusion, graded impurity distribut relations, high field transport charge injection and quasi Fe er generation and recombination, characteristics of excess	ion, Hall Effect, sc ermi levels. Non-Eq carriers, excess carr	atterin uilibriu rier lif	ng in s um Exc etime,	emicon cess Ca introdu	arriers in uction to
Module 3: PN Juncti	on diode and Optoelectronics devices			8		20
PN junction and heter state conditions, transi Devices, Overview of Emerging optoelectron	p-structures: basic structure and principle of operation, pn ju ent and ac conditions, reverse bias breakdown, metal semicon f optoelectronics ,Historical background, IMPORTANCI nics Technology, Photonic Integrated Circuits.	unction under bias, j nductor junctions.Int E AND APPLICAT	unction roduct TIONS	n capac tion to (5: phot	itance. Optoele odiode	, steady ectronic , LED,
Module 4: Bipolar ju	nction transistor			8		20
Bipolar Junction Trans	stors: Fundamental operation, amplification with BJTs, ge	neralized biasing an	d equi	ivalent	circuit	models,
Module 5: Field Effe	ct Transistor			8		20
Field – Effect Transisto characteristics, non-idea	rs: Transistor operations. JFET, Metal Semiconductor FET, al effects, CV characteristics, equivalent circuits, carbon na	MISFET, MOSFET no tube FET and it's	` and tl applic	heir op cationH	eration EMTS	s, device

Reference Books

	1. Electronic devices and Circuit Theory", "R. Boylestad", "Pearson Education", 9thEdition
4	2. "Electron devices", "S. Poornachandra, Sasikala", "Scitech", 2nd Edition
-	3. "Electronic Devices and Circuits", "Millman Halkias", "TMH", 2000
4	4. "Electronic Devices and Circuits", "DavidA.Bell", "PHI", 4thEdition
List of Experiments	
	5. Characterization of Semiconductor Materials: Perform experiments to understand the electrical properties of semiconductor materials such as silicon and germanium. Measure parameters like resistivity, mobility, and carrier concentration.
	5. PN Junction Diode Characteristics: Study the I-V characteristics of a PN junction diode under forward and reverse bias conditions. Determine parameters like threshold voltage, forward and reverse bias currents, and ideality factor.
	7. Diode Rectifier Circuits: Construct and analyze various diode rectifier circuits such as half-wave, full-wave bridge, and center-tapped full-wave rectifiers. Measure output voltage, ripple factor, and efficiency.
{	 Zener Diode Characteristics: Investigate the voltage-regulating properties of Zener diodes. Measure the breakdown voltage and dynamic resistance of Zener diodes under different load conditions.
9	9. Bipolar Junction Transistor (BJT) Characteristics: Study the DC and AC characteristics of NPN and PNP bipolar junction transistors. Measure parameters like DC current gain (β), collector current vs. collector-emitter voltage (IC- VCE) characteristics, and output characteristics.
	10. BJT Amplifier Circuits: Design and analyze common-emitter and common-base amplifier circuits using bipolar junction transistors. Measure parameters like voltage gain, input/output impedance, and frequency response.
	11. Field Effect Transistor (FET) Characteristics: Investigate the DC and AC characteristics of both JFET and MOSFET transistors. Measure parameters like drain current vs. drain-source voltage (ID-VDS), transconductance, and output conductance.
	12. FET Amplifier Circuits: Design and analyze common-source and common-drain amplifier circuits using field-effect transistors. Measure parameters like voltage gain, input/output impedance, and frequency response.
	13. Power Devices & Switching Devices: Experiment with power semiconductor devices such as thyristors (SCRs), power MOSFETs, and IGBTs. Analyze their switching characteristics, turn-on and turn-off times, and power handling capabilities.
	14. Optoelectronic Devices: Study the characteristics and applications of optoelectronic devices such as light-emitting diodes (LEDs), photodiodes, and phototransistors. Measure parameters like emission wavelength, forward voltage drop, and responsivity.

Course title:	WORKSHOP TECHNOLOGY	Sub code:	2LP11				
		Structure:	L	Т	Р	C	
			0	1	4	3	
Course Objective:	To develop the technical skills of creating entities from raw materials. To give "hands on" training and practice to students for use of various tools, devices, equipment and machines. To develop ability to understand, plan and implement various processes and operations to be performed on the raw material to create object of desired shape and size.						
Course Outcome:	 Acquire practical skills in using workshop tools and n Understand safety protocols and practices essential fo Learn fabrication techniques including welding, mach components. Gain knowledge of different materials, their propertie applications. Develop problem-solving abilities through hands-on emechanical components and systems. 	 Acquire practical skills in using workshop tools and machinery for basic metalworking processes. Understand safety protocols and practices essential for working in workshop environments. Learn fabrication techniques including welding, machining, and casting for manufacturing components. Gain knowledge of different materials, their properties, and selection criteria for engineering applications. Develop problem-solving abilities through hands-on experience in assembling and disassembling mechanical components and systems. 					

Content	No. of hours	ESE Marks	(%)
Module 1: Fitting	8		20
Use and setting of fitting tools for chipping, cutting, filing, marking, centre punching, drilling, t			ork to include
one job involving following operations: filing to size, drilling and tapping.			
Module 2: Carpentry		8	20
Use and setting of hand tools like hacksaws, jack planes, chisels and gauges for	construction of vario	ous joints, woo	od tuning and
modern wood turning methods. Term work to include one carpentry job involvi	ng ajoint and report	on demonstra	tion of a job
involving wood tuning.			
Module 3: Electrical and Electronics		8	20
Introduction to basic electrical devices and its measurement. Introduction to basic	knowledge of electr	ronics compon	ent.
Module 4: Welding		8	20
Use and setting of tools and equipment's for edge preparation for welding	jobs and Arc weld	ing fordifferen	nt job like,
Lap welding of two plates, butt welding of plates.			
Module 5: Machining, CNC Machines & Foundry.		8	20
At least one metal tuning job is to be demonstrated. One job on CNC Lathe and C	NC Milling machine	to bedemonst	rated. At
least one demonstration of mould making.			
Reference Books			
 S K Hajra, CHoudhury, A K Hajra, CHoudhury, & Nirj Technology, Vol. I & II. 	har Roy, Elements o	fWorkshop	
2. B S Raghuwanshi, A Course in Workshop Technology	Vol. 1 & II.		
3. W A .l Chapman, Workshop Technology, Part I, ll & II	I		

list of Experi	iments
	1. Wood sizing exercise in planning, marking, sawing, chiselling and grooving to make
	1. Half lap joint
	2. Cross lap joint
	2. Exercise in arc welding for making
	1. Lap joint
	2. Butt joint
	3. Preparation of sand mould for the following
	1. Flange
	2. Anvil
	4. Preparation of joints, markings, cutting and filling for making
	1. V-joint
	2. T-joint
	5. Making of small parts using sheet metal
	1. Tray
	2. Funnel

Course title:	COMMUNICATION SKILL	Sub code:	2LP12			
		Structure:	L	Т	Р	С
			1	1	2	3
Course Objective:	 The primary objective is to develop in the under-graduate students of engineering a level of competence in English required for independent and effective communication for academic and social needs. To impart to the students the skills that they need in their academic, and later in their professional pursuit. To train the students to adopt an innovative approach to English language teaching and learning. 					
Course Outcome:	 Understand the principles and technologies be analog and digital transmission. Analyze and design communication networks error control coding. Gain proficiency in using software tools for se and protocols. Explore emerging technologies such as wirel satellite communication. Develop practical skills in configuring and networks. 	 Understand the principles and technologies behind various communication systems including analog and digital transmission. Analyze and design communication networks using modulation techniques, multiplexing, and error control coding. Gain proficiency in using software tools for simulating and analyzing communication systems and protocols. Explore emerging technologies such as wireless communication, optical communication, and satellite communication. Develop practical skills in configuring and troubleshooting communication systems and 				luding g, and /stems n, and is and
Content		No. of hours	ES	E Ma	rks (%)
Module 1: Commu	inication & Listening	8	3		,	20
An introduction - I English for Specific talks, class room le in the corporate wo Module 2: Reading Introduction of diff inferring, predicting Building self-confid	ts role and importance in the corporate world, Tools of com c purposes and English for technical purposes, Listening proce ctures, Problems in comprehension & retention, Note-taking rld. g & Speaking Ferent kinds of reading materials: technical & non-technical, I g and responding to content, Guessing from context, Note mal dence & fluency, Conversation practice, Improving respondi	munication, Barriers, L ss & practice, Exposure practice, Listening tests Different reading strateg ing, Vocabulary extensing capacity, Extempore	e to rec s- Impo gies: sk sion. Ba e speec	of con orded ortance 3 immin arriers h prace	nmunic & stru- e of lis ng, scar to spe ctice, S	cation, ctured tening 20 nning, aking, speech
assessment. Module 3: Writing	2		8	3		20
Effective writing pr writing, Cohesion & report writing.	ractice, Vocabulary expansion, Effective sentences: role of a & coherence in writing, Writing of definitions, descriptions&	cceptability, appropriate instructions, Paragrap	eness, t h writin	orevity ng, In	/ y & cla troduct	rity in tion to
Module 4: Engine	ering Ethics		8	3		20
What is profession? Engineering and Professionalism, Models of Professionalism, Types of Ethics or Morality, Engineering Ethics, Variety of moral issues, Responsibility in Engineering, Engineering Standards, The Standard Care, The Positive face of Engineering Ethics, Blame-Responsibility and Causation types of inquiry moral dilemmas, moral autonomy, The problems of Many Hands, Kohlburg's theory, Gilligan's theory Impediments to Responsible Action.						
Engineering as social experimentation, Framing the problem, Determining the facts codes of ethics, clarifying Concepts, Application issues, Common Ground, General principles, Utilitarian thinking respect for persons, Engineer's Responsibility for Safety, Social and Value dimensions of Technology, TechnologyPessimism, The Perils of Technological Optimism, The Promise of Technology , Computer, Technology Privacy and Social Policy, Honesty, Integrity & Reliability, Risk, Safety and Liability in Engineering, Risk Benefit Analysis – Collegiality and loyalty.						
Reference Books						

	1. Krishna Mohan and Meenakshi Raman (2000) Effective English Communication, Tata McGraw Hill, New Delhi.
	2. Meenakshi Raman and Sangeetha Sharma (2006) Technical Communication, OxfordUniversity Press, New Delhi.
	3. M. Ashraf Rizvi (2005) Effective Technical Communication, Tata McGraw-Hill, New Delhi.
	4. Christopher Turk (1985) Effective S peaking, E & FN Spon, London
	5. Golding S.R. (1978) Common Errors in English Language, Macmillan.
	6. Mike Martin and Roland Schinzinger, "Ethics in Engineering" McGraw Hill
	7. Charles E Harris, Micheal J Rabins, "Engineering Ethics, Cengage Learning
	8. Edmund G Seebauer and Robert L Barry, "Fundamentals of Ethics for Scientists and Engineers,
	Oxford University Press
	9. Caroline Whitback Ethics in Engineering Practice and Research, CambridgsUniversity Press.
List of Experiments	
	1. Conduct workshops focusing on public speaking techniques, including voice modulation, body
	language, and speech organization.
	2. Organize group discussion sessions on engineering-related topics to improve students ability to express their ideas articulately and persuasively
	 Assign students to prepare and deliver technical presentations on engineering topics relevant to their
	specialization.
	 Conduct mock job interviews to help students develop effective communication skills for professional settings.
	5. Assign students to write technical reports on engineering projects or research findings.
	6. Provide guidance on writing professional emails for various purposes, such as inquiry,
	collaboration, and project management.
	<i>i</i> . Explore the importance of cross-cultural communication in engineering projects with diverse team members and stakeholders.
	8. Conduct negotiation and conflict resolution simulations to help students develop interpersonal
	communication and problem-solving skills.
	9. Organize sessions where students present technical posters summarizing their research projects or
	engineering designs.
	10. Arrange networking events where students can interact with professionals from the engineering
	industry, academia, and related fields.

Course title:	ENGINEERING MATHEMATICS - III	Sub code:	3L13			
		Structure:	L	Т	Р	C
			3	1	0	4
Course Objective:	• To Explain the Importance of Numerical Methods in Solving Differential Equations, Integrations, and Algebraic Equations					
	• To Explain the Significance of Laplace and Z Transforms and Their Use in Solving Differential and Difference Equations.					
	• To Apply Different Statistical and Curve Fitting Techniques	to Gain Insights from	Data.			
	• To Describe the Theory of Complex Variables					
Course Outcome:	• Master advanced mathematical techniques including vector engineering applications.	calculus and complex a	analys	is foi	•	
	• Apply Laplace transforms and Numerical methods to solve problems.	differential equations a	rising	in er	iginee	ering
	• Develop proficiency in numerical methods for solving Com	plex Variable Integration	on pro	blem	IS.	
	• Explore probability and statistics concepts relevant to engin	eering decision-making	g and	data a	analys	sis.
	• Utilize mathematical modeling to analyze and solve real-wordisciplines.	orld engineering problem	ms in	vario	us	

Content		No. of hours	ESE Marks	
Module 1. Numerical 1	Method	8	20	
Lagrange's interpolation	n formula Numerical differentiation solution of ordinar	differential equation	n hyPicard's method	
Taylor's series method	Fuler's modified method and Runge-Kutta method	anterentiar equation	ni byricaid s method,	
Madula 2. Lonlaga Tu		0	20	
Wodule 2: Laplace Transform 8 20				
Laplace Transform, D	efinition, and Properties, Laplace transform of element	ary function, deriva	atives, integrals. Inverse	
Laplace transforms conv	volution theorem solution of LDE by Laplace Transform.			
Madula 2. Statistics		0	20	
Windule 5: Statistics		0	20	
Measures of central ter	ndency, Measures of dispersion, Moments, skewness, Ku	rtosis. Correlation,	Coefficient of Correlation,	
lines of regression of bi	variate data, fitting of curve, least square principle.			
Module 4: Complex Va	ariable- Integration	8	20	
Contour integrals, Cauc	chy-Goursat theorem (without proof), Cauchy Integral for	mula (without proof), Liouville's theorem and	
Maximum-Modulus the	orem (without proof); Taylor's series, zeros of analytic fun-	ctions, singularities,	Laurent's series; Residues,	
Cauchy Residue theorem	n (without proof), Evaluation of definite integral involving	sine and cosine, Eva	luation of certain improper	
integrals using the Bron	nwich contour.			
Module 5: Z Transform	m &Vector Calculus	8	20	
Z- Transform, Z-transfo	orm of elementary function & properties. Inverse Ztransform	ns. Solution of differ	enceequation by Z-	
transforms.				
Vector calculus, different	ention, gradient, divergence, curl of vector function. Ve	ector integration. G	reen'sTheorem, stoke's	
theorem, Gauss diverge	nce theorem. Irrorational & solenoidal fields.			
Reference Books				
	1. P.N. Wartikar and J.N.Wartika, A Text Book of Engin	eering Mathmatics (Vol. I &II)	
	2. B.S.Grewal, Higher Engineering Mathematics, Khann	a Publicatons, New	Delhi	
	3. Erwin Kreyszing, Advanced Engineering Mathematics, Willey Eastern Ltd.			
			-	
Course title:	C/C++ PROGRAMMING	Sub code	3LP14	

Course the.		Sub coue		JLI 14					
	-	Structure	L	Т	Р	С			
			2	1	2	4			
Course Objective:	• To introduce basics of programm	To introduce basics of programming and develop logical thinking ofstudents.							
	• To help students understand how develop practical programming statements and the statement of the students and the statement of the statemen	v to model real world problems skills of students.	into the	softv	vare a	nd			
	• To implement mathematical stat	istical, applications into progra	mming.						
Course Outcome:	 Master the syntax, semantics, an languages. 	• Master the syntax, semantics, and basic programming constructs of the C/C++ languages.							
	• Develop problem-solving skills exercises.	• Develop problem-solving skills through algorithmic thinking and programming exercises.							
	 Understand memory management programming. 	• Understand memory management, pointers, and data structures for efficient programming.							
	• Gain proficiency in modular pro	gramming, debugging, and tes	ting tech	nique	s.				
	 Apply object-oriented programm solutions for engineering problem 	ramming principles to design and implement software roblems.							
Content		No. of hours	ESE	Marl	ks(%)				
Module 1: Introduction	on:	8	20						

Flow charts, data types and storage classes, scope of variables, arithmetic operators, assignment, conditional, arithmetic expressions, enumerated data types, decision making, branching, looping, Switch concept, function and parameter passing, recursive functions, macros.

macros.							
Module 2: Basic programming algorithms:	8	20					
Programs to illustrate basic language constructs in C like - Factorial, Si	ne/cosine and other ma	athematical series, Fibonacci series,					
calculating square-root of a number, calculating GCD of 2 integers (Eucli	id's method and otherw	vise), Calculating LCM of 2 integers					
and similar such programs.	0						
Module 3: Arrays and applications in C language:	8	20					
Introduction to one dimensional and 2-D array with examples. Repr	resenting a polynomia	l using 1-D array and polynomial					
operations, use of 2-D array to represent a matrix and matrix operations. Character arrays (strings): String related functions (strien,							
Bubble sort Insertion sort Linear and binary search partitioning an arra	v merging of 2 sorted	arrays Introduction to "Divide and					
Conquer" via Mergesort and Quicksort.	, morging of 2 solice						
Module 4: Structures, Unions and Pointers in C language:	8	20					
Basic concept, array of structures and its applications. Introduction (dec	laration and initializati	on), pointers and arrays, concept of					
dynamic memory allocation, use of pointers to represent variable- sized	1-D and 2-D arrays, po	binters to structures.					
Module 5: C++ programming concepts	8	20					
Introduction to Object Oriented Concerts Factures of Object ariented a	rogramming (OOD) C	lassas and Objects: Creating a Class					
The Self Variable Constructor Types of Variables Namespaces Types	of Methods Encapsul	asses and objects: Creating a Class ation Module Packages Inheritance					
and Polymorphism: Constructors in Inheritance. The Super Function. Ty	or Methods, Encapsul opes of Inheritance, Pol	whether we want was a set of the					
Interfaces.	peo or initeritanee, i o						
Reference Books:							
1) Kerninghan; Ritchie, "C programming Language", PHI							
2) Theraja B.L., Electrical Technology, S. Chand Publishers							
3) Balguruswamy, "Programming in ANSI C", Tata Mcgraw Hill Publ	ishing						
4) Kakde and Deshpande, "C and data Structure", Charles River Media	a Publisher						
5) Dromey R G, "How to Solve it by Computer", PHI							
6) "Programming in C++ (A Practical Approach)", C. S. Sharma Publi	sher, Oxford Universit	y Press					
List of Experiments:							
1) Write a Program to calculate and display the volume of a CUBE (8cm).	having its height (h=	10cm),width (w=12cm) and depth					
2) Write a program to take input of name, roll no and marks obtain and display the name, roll no with percentage score secured	ed by a student in 5 s	ubjectseach have its 100 full marks					
3) Simple Arithmetic Operation							
4) Write a C program to check whether a number is even or odd using	ternary operator						
5) Write a C program to find the sum of individual digits of a positive	integer						
6) Write a C program to mint the numbers in triangular form							
7) Write a C program to find the second largest integer in a list of integers							
8) Write C programs that use both recursive and non-recursive functions							
 Write a C program to perform arithmetic using Switch Statement Write a C program to perform arithmetic using Switch Statement 							
10) Write a C program to perform factorial							
11) Write a C program to print Eibonacci no							
11) write a C program to print ribonacci no.							

- 12) Write a Simple Calculator Program using C++
- 13) Write a student database management Program using C++

Course title:	Power Electronics	Sub code:	3L1	5		
		Structure:	L	Т	Р	С

			2	0	0	2		
Course Objecti	 This course aims to explore the fundamental characteristics and operational principles of various semiconductor devices, providing students with a comprehensive understanding of their behavior and applications in electronic circuits and systems. Students will develop proficiency in analyzing different types of power electronic converters, including their topologies, control strategies, and performance characteristics, enabling them to evaluate their suitability for various power conversion applications Students will gain practical experience in applying different types of power electronic converters in real-world scenarios, facilitating their ability to design, implement, and troubleshoot power conversion systems effectively. 							
		 Understand the principles and characteristics of power semiconductor applications in electronic power conversion. Analyze and design power electronic circuits for various applications i inversion, and conversion. Gain proficiency in control techniques for regulating voltage, current, electronic systems. Explore the integration of power electronics in renewable energy syste and industrial applications. Develop practical skills in simulation, testing, and troubleshooting of pcircuits and systems. 	 Understand the principles and characteristics of power semiconductor devices and their applications in electronic power conversion. Analyze and design power electronic circuits for various applications including rectification, inversion, and conversion. Gain proficiency in control techniques for regulating voltage, current, and power in power electronic systems. Explore the integration of power electronics in renewable energy systems, electric vehicles, and industrial applications. Develop practical skills in simulation, testing, and troubleshooting of power electronic circuits and systems. 					
Content No. of hours						(%)		
Phase controlled Harmonics and Cycloconverter.	d (AC/DC), power facto	1-phase/3-Phase, Semi/full/dual; Analysis and performance with passive load, or; Voltage controllers (AC/DC), Typical control circuits for integral control/	, Typi phase	cal contr	ontrol col str	circuit; rategies,		
Module 2: Chopper 8					20			
Basic chopper c Source filter	classificatior	n, Basic chopper operation, Control strategies, Chopper configuration, Thyrist	orcho	pper	circui	.t,		
Module 3: Inve	erter	8			20			
Classification o inverter, Voltag inverters, Parall	f inverter, S e control of el inverter, G	Single Phase: Half bridge voltage source inverters, Full bridge inverter, Per f inverter, PWM inverter, Three phase inverter, Classification of Resonant Co Current source Inverter, and Harmonic reduction.	rform nverte	ance er: Se	paran ries r	neter of esonant		
Module 4: Con	trol of DC	Drives and AC drives 8			20			
Criteria for select schemes for DC converter drives control method,	cting drive of motor spee s, PLL drive Closed loop	components, Basic characteristics of DC and its equivalent circuit, Methods of ad control, DC drives, and adjustable speed DC drive. Single phase drives/Three s, Closed loop control of DC drives, Basic principles of operation and its chara p control of inductionmotor drives, Adjustable AC drives.	DC n e pha acteris	notor se dri stics, s	contr ves, I Speed	ol DC-DC I		
Module 5: Pow	er Electron	ics Application 8			20			
Battery charging regulator, Flasher circuits, Protective SCR circuits, Ring counter, Time delay circuits, UPS, SMPS, Static relay, Emergency lightening system, Single phase preventer, Servo controlled voltage stabilizer, Temp Controller, Static circuit breaker, Renewable energy sources and energy storage system to the utility grid.								
Reference Bool	ks							
	1 P.0	C. Sen , "Power Electronics", Tata McGraw Hill						
	2 M.H. Rashid , " Power Electronics " , John Wiley & Sons							
	3 Ger	neral Electric, "SCR manual "						
	4 G.	K. Dubey, S. R Doradle, "Thyristorised Power Controller"						
	5 J. N	5 J. M. Jalnekar and N. B. Pasalkar, "Power Electronics "Technical Publication						

6	Ned Mohan, T.M. Undeland and W.P. Robbins, "Power Electronics: Converters, Applications and Design", John Wiley, Singapore, 1994
7	M D Singh and K. B Khanchandani, "Power Electronics", Tata McGraw Hill
8	B.K.Bose, "Power Electronics & A.C. Drives", Prentice Hall, 1986.

Course title: Electronic Me	asurement and Instrumentation	Subject	t code: 3LP16	L	Т	Р	С
				2	0	2	3
Course Objective:	The primary objective of this course is to provide stude the fundamental principles underlying various measuri practical demonstrations, and hands-on laboratory exer concepts and operational mechanisms of a wide range	ents with ng instru- cises, stu of measu	a comprehens ments. Throug idents will exp ring instrumer	ive un h the lore to	nderst oretic he un ed in o	andin al lec derly electr	ig of tures, ing ronic
Course Outcome:	 Understand the principles and operation of electron and electronic parameters. Learn techniques for accurate measurement, calibration and systems 	nic measu	uring instrumen d error analysis	nts us s in el	ed for	r elect	trical rcuits
	 Gain proficiency in the design and implementation engineering applications. Explore advanced topics such as sensors, transduce systems. Develop practical skills in laboratory experiments, instrumentation tools and techniques. 	of instru ers, signa data acqu	umentation syst l conditioning, uisition, and an	tems ; , and nalysi	for va data a s usir	rious Icquis 1g mc	sition odern
Content	T	No.	of hours	ESI	E Ma	rks(%	6)
Module 1: Fundamentals	of Electronic Measurement and Instrumentation	8		20			
instruments and measurement Theory of errors ,Accuracy measurement. Module 2: Electromechani Construction of Galvanomet AC voltmeters; Peak, averag instruments, Watt-hour mete DC Bridges : Wheatstone I Bridge, Desauty's Bridge, M	nt systems, Applications ofmeasurement system, Elements of and Precision, Types oferrors, Statistical analysis , proba cal Instruments and AC, DC Bridges ter, Suspension Galvanometer, Torque and deflection Galva e and true RMS voltmeters; Digital Millimetres; Ammeters er; Power factor meter. Bridge, Kelvin Bridge. AC Bridges and their applications Wein Bridge, Detectors for AC bridges.	of measur bility of anometer , Ohm-m s: Maxwe	rement system, errors, Limitin 8 c, PMMC mech neters and their ell's Bridge, H	, Type ng err hanisi desig Hay's	es of i rors,S m, DC gn' AC Bridg	nstrui tanda 20 2 volt 2 indi ge, S	ments, rds of meter; icating chering
Module 3: Transducers an	d sensors		8			20	
Static and dynamic character transducer, Displacement The transducers, Transducers for Sensors: Thermocouples, H Nuclear Thermometer, Ma Noise Thermometry, Heat Junctions, Sensors Based O Based Sensors, Biosensors, Sensors, Capacitive Sensors	ristics of Transducer, Classification of transducers, Capaci ransducer, LVDT, RVDT, Strain Gauge, RTD, Optical Tra measurement of Pressure, Temperature, Level, Displaceme Piezoelectric Sensors, Pyroelectric Sensors, Electrochem agnetic Thermometer, SemiconductorTypes, Thermal Ra Flux Sensors. Position Encoders, Resonant Sensors, SAV on MOSFET Transistors, Charge-Coupled And CMOS Im- Proximity Sensors: Typical Sensor Characteristics, Technol, Magnetic Sensors.	tive trans unsducers ent, Flow uical. Sen adiation, V Sensor age Sens ologies F	sducer, Inducti s, Hall effect tr Sensors and it sors, Acoustic Quartz Crysta s, Sensors Ba ors, Fiber-Opt ForProximity S	ve tra cansdu ts type c Tem d, N(sed C tic Se ensin	nsduc acer, 1 as. Th perat QR, S On Se nsors g, Ele	er, Ro Piezo ermo ure S pectro micon , Ultr ectro-	esistive electric electric ensors, oscopic nductor asonic- Optica
Module 4 Signal generator	and Signal Analyzer		8		· · · · ·	20	
CRO: Types, Dual trace, Hi Sine-wave generator, standa generator. Construction and Logic analyzer; Signal cond	gh frequency, sampling and storage oscilloscopes, Applica rd signal generators, Audio frequency signal generation, R operation of Signal analyzer, Wave analyzer, Harmonic itioning and its necessity, process adopted in	tions of C F genera c Distort	CRO.Signal Ge tor, Pulse gene ion analyzer,	enerat erator Spect	tors: I , Fund truma	ntrod ction nalyz	uction,

Module 5: Data Acqui	isition System
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Signal conditioning, Functions of ,Signal conditioning, AC/DC Conditioning systems, Dataconversion: ADC, DAC, Generalized data acquisition system: single channel and multi-channel DAS.

Reference Books		
]	1. A.C PH	D. Helfrick and W.D. Cooper: "Modern Electronic Instrumentation and MeasurementTechniques", I Publications.
	2. A.K Pub	X. Sawhney : "Electrical and Electronic Measurement and Instrumentation", DhanpatRai & Sons lications
	3. S.S.	. Kalsi : "Electronics Measurements", Mc Graw Hill Publications.
2	4. B.H	I. Oliver and J.M Cage : "Electronics Measurement and Instrumentation", Mc GrawHill Publications
List of Experimen	ıts	
	1.	Displacement measurement using LVDT
	2.	Force/ Pressure measurement using Strain Gauge
	3.	Study of Data Acquisition System
	4.	Study of Lab VIEW software
	5.	Study of Lab VIEW projects, SubVIs, Block Diagram, Front Panel
	6.	Use of Loops, Case Structure, Sequence, Timing, Formula Node, Expression Node
	7.	Use of Arrays and Clusters
	8.	Study of Lab VIEWs Visual display
	9.	Exploring String and File I/O
	10	Data Acquisition in Lab VIEW

Course title:	Digital Logic and Circuits	Sub code:	3LP						
_		Structure:	L	Т	Р	C			
			2	1	2	4			
Course Objective:	This course aims to p electronics, including and methods for conv	• This course aims to provide students with a foundational understanding of digital electronics, including various number systems such as binary, decimal, and hexadecimal, and methods for conversion between them.							
	 Students will learn to gates, as well as unive understand the fundar 	Students will learn to design and construct basic logic gates such as AND, OR, and NOT gates, as well as universal logic gates like NAND and NOR gates, enabling them to understand the fundamental building blocks of digital circuits.				NOT			
	• Through theoretical search and learn different me analyze and optimize	Through theoretical study and practical exercises, students will delve into Boolean algebr and learn different methods for simplifying Boolean expressions, empowering them to analyze and optimize digital logic circuits effectively.							
	• Students will explore flops, including D, JK circuits for various ap	e sequential logic circuits and gain insight into the operation of flip- K, and T flip-flops. They will learn to design and construct sequential applications, fostering a deeper understanding of digital system design.				flip- Iential Iesign.			
	• Through hands-on exprogrammable logic of will learn about their preparing them for pr	perimentation and theoretical study, studen evices (PLDs), shift registers, counters, an architecture, functionality, and application actical implementation in real-world engin	nts will Id mem Is in dig eering j	invest ory de ital sy projec	igate evices. stems, ts.	They			
Course Outcome:	• Understand the funda techniques.	mentals of digital logic gates, Boolean algo	ebra, an	d logi	c minii	nization			

	• Analyze and design combinational and sequential l	ogic circuits	for digi	tal systems.				
	• Gain proficiency in implementing digital circuits using standard integrated circuit families such as TTL and CMOS.							
	 Explore advanced topics including synchronous and asynchronous sequential circuits, memory elements, and programmable logic devices. 							
• Develop practical skills in circuit simulation, design verification, and troubleshooting using software tools and laboratory experiments								
Content	software tools and laboratory experiments.	No. of hou	ırs	ESE Marks(%)				
Module 1: Number Syste	n & Codes	8		20				
Number systems and their Division), Diminished rac and correction.	inter-conversion, Binary Arithmetic (Addition, Subtraction ix and radix compliments, BCD codes, Excess-3 code, G	, Multiplicat ray code, H	ion and amming	gcode, error detection				
Module 2: Logic Gates &	Logic Families		8	20				
Digital Logic Gates, Var MOS and CMOS devices converter circuits.	ous Logic Families like RTL, DTL, TTL and ECL, I2L, TTL CMOS Interfacing, IEEE/ANSI-representation of L	., working a .ogicFamilies	and their s A to	ir characteristics, D and D to A				
Module 3: Combinationa	Logic Designs		8	20				
Boolean Algebra, Basic Theorems and properties of Boolean Algebra, Boolean Functions, Canonical and Standard forms-map method, Two, Three, Four and Five variable maps, Sum of products and Product of Sums Simplification, NAND and NOF implementation, incompletely specified functions, Ex-OR functions, K map using 2 variable ,3 variable, and 4 variables.Binary adder and subtractor, Multiplexers, Encoder Decoders/De-multiplexers, Read Only Memory, Programmable Logic Arrays Programmable Array Logic Implementation of Combinatorial Logic using these devices								
Module 4: MSI and PLD	Components		8	20				
Read Only Memory, Prog these devices.	rammable, Logic Arrays, Programmable Array Logic, Impler	nentation of	Combin	atorial Logic using				
Module 5: Sequential Log	ic Design and FSM		8	20				
Introduction, S-R Flip-flop of flip-flop, Classification diagrams; Design of Mealy	s, JK flip-flop, D flip-flop, T flip-flop, master slave flip-flop. of sequential circuits, Register and Counter circuits Int FSM; Design of Moore FSM, Designof IC based counter cir	Flip-flop exc roduction to cuits using 7	itation 7 Finite 490.749	Table, Inter conversionState Machines, State92,74192,74190 etc				
Reference Books								
1	Digital Design: M. Morris Mano, Prentice Hall of India.							
2	Modern Digital Electronic: R.P.Jain (TMH)							
3	Digital Principle and Applications Malvino and Leach- (ГМН)						
4	Modern Digital Systems Design: Cheung (WPC)							
5	Fundamentals of Digital Electronics: Anand Kumar (PHI)						
6	Subrata Ghosal, "Digital Electronics," Cengage publicati	on, 2nd editi	on, 201	8				
7	A. K. Singh, "Foundation of Digital Electronics & Logi	c Design," N	lew Ag	e Int.Publishers.				
8	D.v. Haii, Digital Circuits and Systems, Tata McGraw	HIII, 1989.		·				
9	W.H. Gothmann, "Digital Electronics- An Introduction PHI, 2 nd edition, 2006.	to Theory a	nd Prac	tice,"				
list of Experiments								
1	Introduction to digital electronics lab- nomenclature of d sheet, Concept of VCC and ground, verification of the trut of logic gates using TTL ICs.	igital ICs, sp h tables	pecificat	ions,study of the data				
2	2 Implementation of the given Boolean function using logic gates in both SOP and POS forms.							

3	Verification of state tables of RS, JK, T and D flip-flops using NAND & NOR					
	gates.					
4	Implementation and verification of Decoder using logic gates.					
5	Implementation and verification of Encoder using logic gates.					
6	Implementation of 4:1 multiplexer and 1:4 de-multiplexer using logic gates.					
7	Design of A-D and D-A converter.					
8	Implementation of 4-bit parallel adder using 7483 IC.					
9	Design, and verify the 4-bit synchronous counter.					
10	Design, and verify the 4-bit asynchronous counter.					
11	Implementation of Mini Project using digital integrated circuits and other components.					

Course title:	Linear Electrical Networks	Sub cod	le: 3L	3L18				
	l	Structu	re: L	Т	Р	C		
			2	1	0	3		
Course Objective:	 This course aims to provide students wit covering essential concepts such as volta Students will learn to analyze and solve and Kirchhoff's Current Law (KCL), enal distributions in complex circuits. Through theoretical study and practical examples analyzing AC circuits using KVL and KVC current behavior in electrical circuits. 	h a solid fou ge, current, DC circuits bling them exercises, st CL principle	lid foundation in circuit analysis principles, arrent, resistance, and basic circuit laws. rcuits using Kirchhoff's Voltage Law (KVL) them to determine voltage and current ses, students will develop proficiency in inciples, facilitating the analysis of alternating					
	 Students will learn various circuit analys theorem, and Superposition theorem, and efficiently. This course will enable students to analy correlations between time domain and fr circuit behavior across different domains 	 Students will learn various circuit analysis theorems such as Thevenin's theorem, Not theorem, and Superposition theorem, and apply them to solve complex network probefficiently. This course will enable students to analyze the frequency response of circuits and escorrelations between time domain and frequency domain responses, providing insignation will be a solve and solve a						
	• Through theoretical study and practical of implement various types of filter network band elimination filters, catering to speciapplications.	theoretical study and practical design exercises, students will learn to design and int various types of filter networks including low pass, high pass, band pass, and nination filters, catering to specific frequency domain requirements in practical ons				n and and ical		
Course Outcome:	 Understand the principles of linear circuland network theorems. Analyze and solve linear electrical network independent sources. 	it analysis in orks consist	ncluding Ohm's L	aw, Kir apacitor	chhoff's	s Laws, ctors, and		
	 Gain proficiency in analyzing AC circuit admittance concepts. 	s using pha	sor techniques, ir	impedance, and				
	 Explore the behavior of linear networks under sinusoidal steady-state conditions and tresponses. 					transient		
	various engineering applications.					5 101		
Content			No. of hours	ESE	Marks	s(%)		
Module 1: Basic con	cept of circuit theory & Network Theorems		8		20			

Review of circuit analy	ysis usi	ng Kirchoff's laws, nodal and mesh analysis, solution by classical meth	od and	
Laplace transform, con	ncept of	f independent and dependent sources, analysis of special signal wavefor	rms, and du	ality of networks,
Brief review of Signa	als and	Systems. Superposition and Reciprocity theorem, Thevenin's and N	lorton's the	eorem, Millman's
theorem, maximum po	ower tra	nsfer theorem, compensation, Tellegan's theorem, analysis of circuits u	ising theore	ems.
Module 2: Transient	Analys	is of Networks	8	20
Network elements, T condition, Solution usi	ransien	t response of R-L, R-C, R-L- C for DC and sinusoidal excitation erential equation approach and Laplace transform method. Behaviors of	n, Initial f series and	parallel resonant
Module 3: RLC circu	it and	Resonance	8	20
Laplace transforms a	and pro	operties: Partial fraction, singularity functions, waveform synthes	is, analysi	s of RC, RL, and
RLC networks with	and wi	thout initial conditions with Laplace. Resonance conditions, qua	lity factor,	
Module 4: Two Port	Netwo	rks and Graph theory	8	20
Two Port Networks, G networks, State space	raph th	eoretic analysis for Large scale networks, Formulation and solution of nation, Analysis using NGSPICE.	network gra	ph of simple
Module 5: Passive Fil	lter De	sign	8	20
Butter worth and Ch	nebyshe	ev approximations, Normalized specifications, Frequency transform	nations,	
Frequency and impeda	incede-	normalisation, Types of frequency selective filters, Linear phase filters.		
Reference Books				
	1	"Network and systems" by D.Roy - Choudhary		
	2	"Circuit Analysis - with computer applications to problem Someshwar C. Gupta, Jon W. Bayless, Behrouz Peikari.	solving"	by
	3	Franklin F. Kuo, "Network Analysis and Synthesis", John Wiley.		
	4	Vanvalkenburg, "Network Analysis ", Printice Hall of India Pvt Delhi, 1994.	. Ltd., Ne	W
	5	A William Hayt, "Engineering Circuit Analysis," 8th Edition, M Education.	McGraw-Hi	11
	6	A. Anand Kumar, "Network Analysis and Synthesis," PHI publication	n, 2019.	
	7	Sudhakar, A., Shyammohan, S. P., "Circuits and Network," Tata I New Delhi, 1994.	McGraw-Hi	11

Course title:	Control System Engineering	Sub code:	4L1	4L19		
		Structure:	L	Т	Р	C
			3	0	0	3
Course Objective:	 To introduce different types of system and model a complicated system into a more mechanical systems in terms of electrical analysis. To employ time domain analysis to predict system for standard input functions and ide compensator toascertain the required dynam Formulate different types of analysis in freq system. 	identify a set of algeb simplified form to in system to construct ea and diagnose transient entify the needs of dif ac response from the sy uency domain to expla	raic equati nterpret dif quivalent e performan ferent type ystem. in the natu	ons to ferent electrication ce parations of co ure of s	repress physic al moo meter ontroll tability	ent and cal and lels for s of the ers and y of the

Course Outcome:	 Understand the principles and concepts of control systems including feedback, stability, and performance criteria. Analyze and design control systems using various techniques such as root locus, frequency response, and state-space methods. Gain proficiency in modeling dynamic systems and obtaining transfer functions for control system design. Explore the application of control systems in engineering disciplines such as robotics, aerospace, and industrial automation. Develop practical skills in implementing control algorithms, tuning controllers, and analyzing system responses through simulations and experiments. 							
Content	•		No. of hours	ESE Marks(%)				
Module 1: Introduc	ction to	Control Systems	8	20				
Types of Control Sys Systems, Analogous graphs.	stems, I Systen	Effect of Feedback Systems, Differential equation of Physical ns. Block diagrams and signal flow graphs: Transfer functions	Systems –Mechani s, Block diagram a	ical Systems, Electrical Igebra and Signal Flow				
Module 2: Time Re	sponse	of feedback control systems	8	20				
Standard test signal specifications of sec (excluding design).	s, Unit	t step response of First and Second order Systems. Time rder systems, steady state errors and error constants. Intro-	response specification to PI, PE	ations, Time response and PID Controllers				
Module 3: Stability	analys	is	8	20				
Concepts of stability stability criterion, Int	v, Neces troduct	ssary conditions for Stability, Routh stability criterion, Relat ion to Root-Locus Techniques, The root locus concepts, Con	ive stability analy struction of root lo	sis: more on the Routh ci.				
Module 4: Frequen	cy don	ain analysis and stability	8	20				
Correlation between Polar Plots, (Inverse lag excluded) Introdu	time a Polar uction t	nd frequency response, Bode Plots, Experimental determina Plots excluded) Mathematical preliminaries, Nyquist Stabilit o lead, lag and lead-lag compensating networks (excluding d	ttion of transfer fu ty criterion, (Syste esign).	nction. Introduction to ms with transportation				
Module 5: Introduc	ction to	Digital Control System	8	20				
Introduction, Spectrum Analysis of Sampling process, Signal reconstruction, Difference equations. Introduction to State variable analysis: Introduction, Concept of State, State variables & State model, State model for Linear Continuous & Discrete time systems, Diagonalization.								
	2	Control systems K.D. Vormel, McCosse hill						
	2	Control systems, K.K. varman, McGraw nili						
	3	Control System Engineering, D. Roy Chowdhuri, PHI						
	4	Digital Control system, B.C. Kuo, Oxford University Press.						
	5	Control System Engineering, I. J. Nagrath& M. Gopal. Publication	. New AgeInterna	ational				
	6	Modern Control Engineering, K. Ogata, 4th Edition, Pearso	n Education					

Course title:	Electromagnetics and Field Theory Sub code:		4L20			
		Structure:	L	Т	Р	С
			3	1	0	4

Course Objecti	ive:	• To provide basic skill required to understand and develop applications related to Signals.							
		 To enrich strong foundation on systems in modern communication To develop on understanding on Electrometric systems in the listic system. 							
		• To develop an understanding on Electromagnetic waves and radiating systems							
		• To develop a strong understanding on Antennas							
Course Outcon	ne:	Understand the fundamental principles of electromagnetic fields and their interactions in various mediums							
		 Analyze and solve electromagnetic problems using Maxwell's equations and boundary 							
		conditions.		1.	1				
		 Gain proficiency in understanding wave propagation, Euplore emplications of electromegnetic theory in with 	transmissio	n lines,	and antenna theory.				
		engineering, and photonics.	eless comm	unicatio	n, microwave				
		 Develop problem-solving skills for designing and ana systems. 	alyzing elect	romagn	etic devices and				
Content			No. of hou	irs	ESE Marks(%)				
Module 1: Vec	tor calculus			2	5				
Orthogonal Coo	ordinate Syste	m, Transformations of coordinate systems; Del operator; G	radient,Dive	ergence,	Curl - their physical				
Module 2: Elec	Laplacian ope	erator.		8	20				
Coulomb's Los	<u> </u>	11 Interview Dialds due to Different Change Distribution	Electric E	1 D					
Applications, El	lectric Potenti	ial. Relations Between E and V. Maxwell's Two Equations	s, Electric F s for Electro	static F	ields. Electric dipole.				
Energy Density	, Convection	and Conduction Currents, Dielectric Constant, Isotropic at	nd Homoger	neous D	ielectrics, Continuity				
Equation, Relay	xation Time,	Poisson's and Laplace's Equations, Capacitance - Parall	lel Plate, Co	baxial, S	Spherical Capacitors,				
Illustrative Prob	olems.			10					
Module 3: Mag	gneto statics &	& Maxwell's Equations		10	25				
Biot-Savart La static Fields, M dipole, Inductan Inconsistency of Statements. Bou Problems.	w, Ampere's fagnetic Scala ices and Magi f Ampere's L indary Condit	Circuital Law and Applications, Magnetic Flux Density, ar and Vector Potentials, Forces due to Magnetic Fields, netic Energy, Illustrative Problems. aw and Displacement Current Density, Maxwell's Equation ions of Electromagnetic fields: Dielectric-Dielectric and Di	Maxwell's I Magnetic to ns in Differ electric-Con	Two Economy of the second s	uations for Magneto d moment, Magnetic d Forms and Word interfaces, Illustrative				
Module 4: EM	Wave Chara	cteristics		10	25				
Wave Equations	s for Conduct	ing and Perfect Dielectric Media, Uniform Plane Waves - I	Definition, A	All Relat	tions between E & H,				
Sinusoidal Varia	ations, Wave	Propagation in Lossless and Conducting Media, Conductor stors and Good Dialactrics Polarization Pathection and Po	s & Dielectr	rics – Cł Plana X	haracterization, Wave				
Oblique Incider	nces, for both	h Perfect Conductor and Perfect Dielectrics, Brewster A	ingle, Critic	al Angl	e and Total Internal				
Reflection, Sur	face Impedan	nce, Pointing Vector, and Pointing Theorem - Application	ons, Power	Loss in	a Plane Conductor,				
Illustrative Prob	olems								
Module 5: Trai	nsmission Lii	nes & Antennas		10	25				
Transmission L	Lines: Types,	Transmission line parameters (Primary and Secondary)	, Transmiss	ion line	e equations, Input				
impedance, Star	nding wave ra	tio & power, Smith chart & its applications, Applications of input impedance. Illustrative Problems	oftransmissic	on lines	of various lengths,				
Antenna Conce	pts, Antenna	Characteristic; Hertzian dipole (Radiation Fields, Radia	ation Resist	ance, F	Radiation patterns,				
Directive Gain)	; Properties a	and typical applications of Half-wavedipole, Loop antenn	a, parabolio	c reflec	tor anteena Horn				
antenna, Yagi-	Uda array, A	rray Antennas: End fire and Broadside array							
Reference Bool	ks								
	1 Princ	iples of Electromagnetics, 4th Edition, Matthew O H Sadik	u, Oxford U	niversit	у				
	Press								
	2 Elect	romagnetic Field Theory & Transmission Lines, G.S.N. Ra	ju, Pearson l	Educatio	on				
	3 Electromagnetic Waves Shevgaonkar, Tata-McGaw-Hillr – R K								

4	Engineering Electromagnetics, 2ed Edition - Nathan Ida, Springer India
5	Fields & Waves in Communication Electronics, S. Ramo, J. R. Whinnery& T. VanDuzer, John Wiley
6	Electromagnetic Theory & Applications, A. K. Saxena, Narosa Publishing House Pvt. Ltd.
7	Electromagnetics, 2ed Edition – J. A. Edminister, Tata-McGraw-Hill.
8	Engineering Electromagnetics, 7th Edition-W.H.Hayt& J. A. Buck, Tata-McGraw-Hill

Course title:	Microp	rocessor and Microcontroller	e:	4LP21				
			Structu	re:	L	Т	Р	С
			1		2	0	2	3
Course Objective:		This subject deals about the basic 16-bit (8086 architecture, internal organization and their f processors/ controllers.	b) processo unctions,	or and an 8-b interfacing a	oit (8 n ex	8051) aterna) cont al dev	trollers, their vice with the
 Course Outcome: Understand the architecture, instruction set, and operating microcontrollers. Analyze and design digital systems using assembly lang microprocessors. Gain proficiency in interfacing peripheral devices and peripheral					proc amm g inj	esson ning f put/o	for torutput	operations.
		 Explore embedded system design concepts i software development tools. Develop practical skills in programming, def systems for various applications. 	bugging, a	and testing mi	icro	contro	oller-	based
Content				No. of hours	5	ESE Marks(%)		arks(%)
Module 1: 8086 Arch	hitecture			8				20
Introduction to advan immediate & Register Address translation, M	nced micr r data, Me Aemory or	coprocessors, 8086 internal architecture, Memo emory accessing. 8086 minimum/maximum mod rganization, Paging.	ory, Orgar le system,	nization, Add Real and Pro	lress otect	ing i ed m	mode odes	s, Accessing of operation,
Module 2: 8086 Instr	ruction Se	et		8				20
8086 data transfer in Unconditional branch Examples, Hardware i	nstruction instruction interrupt a	s, Arithmetic instructions, Bit manipulation ons, Processor control instructions, Overview o applications, Multiple interrupts, 8259 a interrup	instruction f 8086 int t controlle	ns, String in errupts respo er, Examples	stru onses usin	ction s, 808 g 825	s, Co 36 int 59 A y	onditional & errupt types, with 8088.
Module 3: Keyboard	l & Displa	ay interfacing		8	8 20			20
Keyboard interfacing, description, Software	, interfacin	ng LED displays, 8279 keyboard/ display contr , Interface considerations, Circuit connections w	oller, Blo 7 th 8086.	ck diagram, 1	Pin	descr	iptior	ı, Functional
Module 4: Advanced	l Micropr	ocessors		8				20
Introduction to Pentium and Pentium pro architectures: RISC concepts, BUS operation, Super scalararchitecture, Pipelining Introduction to Pentium II, Pentium III and Pentium 4 processors. RISC Architecture : Properties of RISC Systems Comparison with CISC architecture.								
Module 5: Introduction to Microcontrollers820						20		
Study of micro controller (MCS 51 family- 8051) - Architecture - Comparison of various families of 8 bit micro controllers. System design techniques interfacing of LCD, Stepper motor, Keyboard and ADC /DAC using microcontrollers. Study of micro controller 8096 - Architecture, Typical application in automotive and other industries, Introduction to super pipelined super scalar architectures of microcontrollers.								

Reference Books

	1	D. Hall, "Microprocessor and Interfacing (8086), 2nd ed, TMH
	2	Gibson, "Microprocessor and Interfacing", 2nd edition, PHI
	3	Triebel and Singh, "The 8088 and 8086 Microprocessors : Programming, Interfacing, software,
		Hardware and Applications ", PHI
	4	Brey, " Intel Microprocessors, 8086 to Pentium and Pentium pro processor:Architecture,
		Programming and interfacing", 4th edition, PHI / Pearson
	5	Ajay Deshmukh, "Microcontrollers (Theory and Applications) –TMH
	6	M.A. Mazidi&J.G.Mazidi, The 8051 Microcontroller and Embedded systems 3rdIndian reprint, Pearson
		Education.
list of Experime	nts	
	1	Microprocessor 8086 based development system
	2	Simple arithmetic programs
	3	Array manipulation programs
	4	Code conversion programs
	5	LED Bank interface
	6	ADC ,DAC interface
	7	Stepper Motor interface
	8	Programming exercises in c and assembly language covering program and data memory
	9	i/o port, Peripheral and external interrupt, power saving modes
	10	Interfacing of devices like keys, relays, leads, seven segment, LCD Module, Matrix keyboard etc.

Course title:	Analog Communication Sub code:		4LP22					
		Structure:	L	Т	Р	C		
			2	0	2	3		
Course Objective:	 This course aims to provide students with a comprehensive understanding of the fundamenta and components of analog communication systems, covering topics such as modulation, den and transmission techniques. 							
	• Students will learn to analyze and evaluate different a including amplitude modulation (AM), frequency modenabling them to comprehend their applications and p	Students will learn to analyze and evaluate different analog modulation and demodulation techniques, including amplitude modulation (AM), frequency modulation (FM), and phase modulation (PM), enabling them to comprehend their applications and performance characteristics.						
	• Through theoretical study and practical demonstration various transmitters and receivers used in analog com understanding of signal generation, transmission, rece	is, students will gain ins munication systems, fac ption, and signal proces	ight i ilitati sing t	nto th ng th echni	ne opera eir iques.	ation of		
	• This course will enable students to understand the effe and its impact on signal quality, signal-to-noise ratio (them to mitigate noise-induced distortions and enhance	se will enable students to understand the effects of noise on analog communication systems apact on signal quality, signal-to-noise ratio (SNR), and system performance, empowering nitigate noise-induced distortions and enhance system reliability. will acquire knowledge about information theory and capacity concepts in analog cation systems, including channel capacity, bandwidth considerations, and transmission 7, enabling them to optimize system design and performance for efficient information ion.						
	• Students will acquire knowledge about information the communication systems, including channel capacity, lefficiency, enabling them to optimize system design a transmission.							

Course Outcome	•	Understand the principles of analog modulation technic frequency modulation (EM) and phase modulation (B)	ues including amp	litude mod	ulation (AM),				
	•	Analyze the performance of analog communication systems in terms of signal-to-noise ratio,							
		bandwidth, and distortion.							
	•	Gain proficiency in designing and implementing analog communication systems including transmitters, receivers, and transmission lines.							
	•	Explore advanced topics such as frequency synthesis, p techniques in analog communication.	hase-locked loops,	and noise	reduction				
	•	Develop practical skills in laboratory experiments, sime systems using modern instruments and tools	ulation, and testing	of analog	communication				
Content		systems using modern msu unients and tools.	No. of hours	ESE Ma	rks(%)				
Module 1: Basics	s of An	nplitude Modulation	8		20				
Elements of comm and Applications. Rectifier detector, modulators, Ring	nunicat Ampli , Envel modula	tion systems, Information, Messages and Signals, Modula tude Modulation & Demodulation: Baseband and carrier ope detector, Double sideband suppressed carrier (DSB- ator, Balanced modulator, Frequency mixer, sideband and podulation (OAM). Single sideband (SSB) transmission	tion, Modulation M communication, A SC) modulation & carrier power of AM Time domain repr	Iethods, M Amplitude 1 its demod M, Generat	odulation Benefits Modulation (AM), ulation, Switching ion of AM signals, of SSB signals &				
their demodulation	n scher	nes (with carrier, and suppressed carrier), Generation of S	SB signals, Vestigia	al sideband	l (VSB) modulator				
Module 2: Angle	Modu	lation &Demodulation		8	20				
Concept of instan band frequency n bandwidth relation Demodulation of 2	taneou nodulat onship, FM, Ba	s frequency, Generalized concept of angle modulation, H tion (NBFM); and Wide band FM (WBFM), Phase mod Features of angle modulation, Generation of FM wand pass limiter, Practical frequency demodulators, Small	Bandwidth of angle dulation, Verification waves – Indirect error analysis,	modulated on of Freq method, I	d waves – Narrow uency modulation Direct generation;				
Module 3: Noise	in Cor	nmunication Systems		8	20				
Types of noise, Ti noise, Envelope o Effective noise ter expression) of AM	ime dor f narro mperat 1, DSB	main representation of narrowband noise, Filtered white r wband noise plus sine wave, Signal to noise ratio & prob ure, and Noise figure, Baseband systems with channel no S-SC, SSB-SC,FM, PM in the presence of noise, Illustration	noise, Quadrature re ability of error, Noi ise, Performance an ve Problems.	epresentationse equivalenalysis (i.e.	on of narrowband ent bandwidth, finding SNR				
Module 4: Analo	g pulse	e modulation schemes		8	20				
Pulse amplitude n Pulse-Time Mode demodulation sch	nodula ulation emes,	tion – Natural sampling, flat top sampling and Pulse amp – Pulse Duration and Pulse Position modulations, ar PPM spectral analysis, Illustrative	plitude modulation nd	(PAM)&	demodulation,				
Module 5: Radio	Recei	vers		8	20				
Pre-emphasis, & I loop, Frequency d ,Illustrative Proble	De-emp livision ems.	phasis filters, FM receiver, FM Capture Effect,. Carrier A multiplexing (FDM), and Super-heterodyne AM receive	cquisition- phased 1 r, Sensitivity and s	locked loop selectivity	p (PLL), Costas , selection of IF				
Reference Books									
	1	B. P. Lathi, "Modern Digital and Analog Communic press, 3rd Edition, 2006	ation Systems," O	xford Univ	ν.				
	2	Sham Shanmugam, "Digital and Analog Communi edition, 2006.	cation Systems",	WileyIndi	a				
	3	A. Bruce Carlson, & Paul B. Crilly, "Communication in Electrical Communication", McGraw-Hill Internatio 5th Edition, 2010.	Systems – An Intronal Edition,	roduction t	oSignals & Noise				
	4	Simon Haykin, "Communication Systems", Wiley-India	a edition, 3 rd editio	on, 2010.					
	5	Herbert Taub& Donald L Schilling, "Principles of C McGraw-Hill, 3rd Edition, 2009.	ommunication Sys	tems", Tai	ta				

George Kennedy and Bernard Davis, "Electronics & Communication System", TMH,2004.

list of Experiments

6

1	Amplitude modulation and demodulation
2	Frequency modulation and demodulation.
3	Characteristics of Mixer
4	Pre-emphasis & de-emphasis.
5	Pulse Amplitude Modulation and demodulation
6	Pulse Width Modulation and demodulation
7	Pulse Position Modulation and demodulation
8	Radio Receiver measurements – Sensitivity, Selectivity, & Fidelity
9	Sampling Theorem – verification
10	Time division multiplexing.

Course title:	ANALOG ELECTRONICS	Sub code:	4L1	4LP23				
		Structure:	L	Т	Р	С		
		·	3	0	2	4		
Course Objective:	 Course Objective: To impart foundational knowledge and understanding of electronic circuits and devices ope continuous time domain, emphasizing analysis, design, and application of analog circuits. To equip students with skills to analyze, design, and troubleshoot analog electronic circuits commonly used in various engineering disciplines, fostering critical thinking and problem-sabilities 							
Course Outcome:	• Understand the principles and char FETs.	racteristics of	f analog electr	onic de	evices	such as diodes, BJTs, and		
	• Analyze and design analog electro	onic circuits i	ncluding ampl	ifiers,	oscilla	tors, and filters.		
	• Gain proficiency in biasing technic circuits.	ques, small-signal analysis, and frequency response of analog						
	• Explore advanced topics such as f	eedback amp	nplifiers, operational amplifiers, and voltage regulators.					
	• Develop practical skills in circuit various applications.	simulation, p	ulation, prototyping, and testing of analog electronic circuits for					
Content			No. of hours	ES	E Ma	rks(%)		

Module 1: Diode and its circuit Transistor Biasing	8	20

Wave Shaping Circuits a) General idea about different wave shapers b) RC and RL integrating and differentiating circuits with their applications c) Diode clipping and clamping circuits and simple numerical problem on the circuits, Transistor biasing and basic characteristics: Operating point, Bias stability, Different biasing arrangements, stabilization, Thermal runway and thermal stability, Small signal low frequency amplifiers, analysis of generalized amplifier models, Transistor hybrid models, Determination and measurement of hparameters, analysis of transistor amplifier circuits using h-parameters

Module 2: Frequency response	8	20

Low frequency response of amplifiers: Cascading transistor amplifiers, calculations for different amplifier configurations, Emitter follower, Miller's theorem, Cascode transistor configurations, few configurations of high frequency response, Basic overview on difference and power amplifiers.

Large Signal Amplifier a) Difference between voltage and power amplifiers b) Importance of impedance matching in amplifiers c) Class A, Class B, Class AB, and Class C amplifiers d) Single ended power amplifiers, push-pull amplifier, and complementary symmetry push-pull amplifier

Module 3: Operational amplifier	8	20

The difference amplifier and the ideal operational amplifier models, concept of negative feedback and virtual short; Analysis of simple operational amplifier circuits; Basic building blocks of op-amp, DC level shifter, Output stage. Review of Op-amp parameters, Frequency response, offset nulling techniques, inverting, non-inverting configurations. Summing amplifier, Difference amplifier, Instrumentation amplifier and applications, Integrator, Differentiator and applications. V to I and I to V converter, Comparators, Limitations of Op-amp as Comparator, Schmitt trigger, Precision rectifiers, Peak detector.

Sine wave generators, Multi vibrators, Triangular wave generators, Saw tooth generators, V to F and F to V, converters, All types of filter responses, First order active filters LP and HP,BPF, band reject and bi quad filters, sensitivity analysis.

8

20

Module 4: Feedback amplifier and Oscillator	

Feedback and operational amplifiers: Feedback concept, positive and negative feedback, different feedback configurations Sinusoidal Oscillators a) Use of positive feedback b) Barkhausan criterion for oscillations c) Different oscillator circuitstuned collector, Hartley Colpitts, phase shift, Wien's bridge, and crystal oscillator. Their working principles and simple numerical problems d) Series and parallel resonant circuits and bandwidth of resonant circuits e) Single and double tuned voltage amplifiers and their frequency response characteristics.

Module 5: Design and Synthesis of Digital Systems	8	20

Multivibration Circuits a) working principle of transistor as switch b) Concept of multi-vibrator: astable, monostable, and bistable and their applications c) Block diagram of IC555 and its working d) IC555 as monostable and astable multivibrator.Regulated DC Power Supplies a) Concept of DC power supply. Line and load regulation, Concept of fixed voltage, IC regulators (like 7805, 7905), and variable voltage regulator like (IC 723) c) Idea of SMPS.

Reference Boo	oks	
	1	RamakantGaikwad, "Op-amps and Linear integrated circuits", PHI
	2	D.RoyChoudhary, Shail Jain, Linear Integrated Circuits, New Age International
	3	Bowans, "Digital Instrumentation", TMH Publications
	4	Waller C. Bosshart, "PCB Design & Technology", TMH
	5	Bert Haskell, "Portable Electronics Product Design and Development", MGH Publication
	6	William Flecther, "An Engineering Approach to Digital Design", PHI
list of Experin	nents	
	1	Study of Diode as clipper & clamper
	2	Summing amplifier / subtractor
	3	Integrator/ Differentiator
	4	Frequency response of active filter (LP/HP/BP)
	5	Voltage regulator ICs LM723
	6	Voltage to Frequency converter
	7	Waveform generator 8038 etc.
	8	Study of Zener diode as a voltage regulator
	9	Inverting amplifier and Non-inverting amplifier
	10	Digital to Analog converter

Course title:	Signals and Systems	Sub code:	4L24				
		Structure:	L	L L	Г	Р	С
			3	0)	0	3
Course Objective:	 This course aims to provide students with a comprehence overing fundamental concepts such as signal classified representations. Students will learn to analyze signals and systems in both the systems in both t	nsive understandi cation, system pro oth continuous a	ing of si operties, nd discr	ignals, and	s and mathe	system ematicans usin	is, al g time
	 domain and frequency domain methods, including tech and Laplace transforms, enabling them to characterize Through theoretical study and practical exercises, stud systems by examining the concept of Region of Conve system analysis, enabling them to assess system stabil 	hniques such as c and manipulate s lents will gain ins ergence (ROC) in ity and robustnes	convolut signals a sight int the cor s.	tion, I and sy to the ntext o	Fourie ystem stabil of sig	er anal ns effec lity of gnal and	ysis, xtively. d
	• This course will familiarize students with various tran and systems, including Fourier transforms, Laplace tra with versatile tools for signal representation, analysis,	sform techniques ansforms, and Z-t and manipulation	used in ransfor n across	the a ms, pi diffe	analys orovidi erent c	sis of s ing the domair	ignals em 1s.
Course Outcome:	 Understand the fundamentals of signals, systems, and Analyze linear time-invariant (LTI) systems using cortransforms. Gain proficiency in analyzing signals and systems in h 	their mathematic volution, Fourier	al repre	senta is, and	itions. d Lap	olace	
	 Call proficiency in analyzing signals and systems in to Explore applications of signal and system theory in co Develop problem-solving skills for designing and anal engineering applications. 	mmunication, co	ntrol, and	nd sig I filter	uns. gnal p ers for	rocessi variou	ing. Is
Content		No. of hour	rs	ESE	2 Mar	·ks(%)	
Module 1: Basics of Signals and LTI systems818							
Continuous Time and and Discrete Time S Continuous Time LT	Continuous Time and Discrete Time signals, Exponential and Sinusoidal Signals, Unit Impulse and Unit Step Functions, Continuous and Discrete Time Systems, basic System Properties. LINEAR TIME INVARIANT SYSTEMS: Discrete Time LTI Systems, Continuous Time LTI Systems, properties of LTI Systems, causal LTI Systems Described by Difference equations			nuous stems,			
Module 2: Fourier s	Module 2: Fourier series representation of periodic signals 8 18						
Response of LTI systems to Complex Exponentials, Fourier series Representation of CT periodic Signals, properties of CT Fourier Series, Fourier Series representation of DT periodic Signals, properties of DFS, Fourier series and LTI Systems, Filtering, Examples of CT filters, Examples of DT filters			ourier mples				
Module 3: Continuo	us time Fourier transform		8			18	
Representation of a periodic Signals by continuous FT, FT of periodic signals, convolution and multiplication property of continuous FT, systems characterized by Linear Constant Coefficient Differential Equations. Magnitude and phase representation of FT, Magnitude and phase response of LTI systems, Time domain and Frequency domain aspects of ideal and non-ideal filters.				nuous of FT,			
Module 4: Laplace	Fransform		6			16	
Definition-ROC-Properties-Inverse Laplace transforms-the S-plane and BIBO stability-Transfer functions-System Response to standard signals-Solution of differential equations with initial conditions.							
Module 5: Discrete Time Fourier Transform (DTFT) And Discrete616Fourier Transform (DFT):616							
SAMPLING: Sampling theorem, Impulse sampling, sampling with zero order Hold, Reconstruction of signal from its samples using interpolation, Effect of under sampling. Properties of DTFT and DFT, convolution property, multiplication property, Duality, Systems characterized by Linear Constant Coefficient Difference Equations.				using ıality,			
Module 6: Z-Transf	orm		4			14	
Z-transform, Region LTI systems using Z	of convergence and its properties, Inverse Z transform, properti Γ, LTI Systems, System function algebra and block diagram rep	es of ZT, Analys presentations.	is andcł	naract	terizat	tion of	

Reference Books	6	
	1	Alan V. Oppenheim, Alan S. Willsky, S. Hamid Nawab, Signals and Systems PrenticeHall India, 2nd Edition, 2009.
	2	John G. Proakis, Dimitris G. Manolakis, Digital Signal Processing, Principles, Algorithms, and Applications, 4th Edition, PHI, 2007.
	3	B.P. Lathi, —Signals, Systems & Communicationsl, 2009,BS Publications.
	4	Simon Hykin, "Signals and Systems", John Wiley
	5	Robert A. Gable, Richard A. Roberts, Signals & Linear Systems, 3rd Edition, JohnWiley, 1995.
	6	Harish Parthasarathy,"Signals and Systems" JK International Second Edition.
	7	HWEI P.HSU Schaum's, "Signals and Systems" TMH
	8	M.J.Roberts,"Signals and Systems" TMH Ed 2003

Course title:	Digital Communication	Sub code:	5LP25			
		Structure:	L	Т	Р	C
			2	0	2	3
Course Objective:	 Understanding the Key Modules of Digital Com Digital Modulation Techniques Designing Systems Involving Randomness Usin Simulations. Learning about Theoretical Bounds on the Rate Description Digital Simulation Strength Mathematical Strength Strength Mathematical Strength Mathematical Strength Mathmatical Strength Mathematical Strength Mathematical Strength	nmunication Systems w ng Mathematical Analy s of Digital Communica	vith E sis ar ation	mphas nd Cor Syster	nputer	l
	 Drawing Signal Space Diagrams, Computing Spectral Mo Redundancy for Reliable Communication. 	pectra of Modulated Sig	gnals	, and A	Applyi	ng
Course Outcome:	 Understand the principles and techniques of dig Analyze and design digital communication syst ASK, FSK, PSK, and QAM. Gain proficiency in error detection and correction Explore advanced topics including spread spect techniques 	ital modulation and den ems using modulation t on codes for reliable dia rum communication an	modu echn gital o d mu	lation iques s commu ltiple a	schem such as unicati access	on.
	 Develop practical skills in simulation, impleme communication systems using software tools and 	ntation, and performand ad laboratory experimer	ce ana nts.	alysis	of digi	tal
Content		No. of hours	ES	E Maı	rks (%))
Module 1: Random	Variables and Random Process	8			20	
Deterministic and Ran Standard distributions distributions. Function	ndom Signal: Types of random variables, cumulative distribu : Gaussian, exponential, Rayleigh, uniform, Bernoulli, binom ns of one random variable: distribution, mean, variance, mom	tion function and proba ainal, Poisson, discrete ents and characteristics	bility unifo func	v densi rm and tions.	ty fund	ctions, itional

Random Processes: Random processes, stationary processes, mean and covariance functions, periodicity, linear filtering of random processes, power spectral density, examples of random processes: white noise process and white noise sequence, Gaussian process, Poisson process, Markov process.

Module 2: Digital communication and modulation basics

20

8

Band pass and Low pass signal, Introduction to Digital communication systems, Pulse code modulation, differential pulse code modulation, delta modulation, adaptive delta modulation, PSD of Line Codingschemes, Pulse shaping, Scrambling, Eye diagram, Gram-Schmidt orthogonalization scheme.

Module 3: Digital Modulation Techniques	8	20
Modulation and Demodulation of Digital modulation schemes-ASK, FSK, PSK, DPSK, QPSK ar	dConstellation	1
diagram. Introduction to M-ary communication.		
Module 4: Digital Communication Through Band Limited Channels and Digital	8	20
Receiver		
Characteristic and signal Design of band Limited Channels. Optimum Receiver for Channel	with ISI and	AWGN. Linear
Equalization, Decision Equalization, Adaptive Equalization. Introduction of Multichannel and	Multicarrier S	System. Optimum
threshold detection, Concept of Matched Filters, BER analysis of BASK, BFSK, BPSK, Mo	odelof Spread	Spectrum Digital
Communication. Direct Sequence Spread Spectrum Signal (DS-SS), Frequency Hopped Spread S	pectrum Signa	l (FH-SS).
Module 5: Information theory and Coding	8	20
Discrete Source models - Memoryless and Stationary, Mutual Information, Self-Informat	tion, Conditio	nal Information,
Average Mutual Information, Entropy, Entropy of the block, Conditional Entropy, Infor	mation Meas	sures for Analog
Sources. Review of probability theory Entropy Mutual information Data compression	Huffman coo	ling Asymptotic
equipartition property Universal source coding Channel capacity Differential entropy Bl	ock codes an	d Convolutional
codes.		

Reference Books

	1	John G. Proakis & Masoud Salehi, "Digital Communications", 5th Edition, McGraw
		Hill
	2	B.P. Lathi, "Modern Digital and Analog Communication Systems", 4th Edition, Oxford University Press
	3	H. Taub, D L Schilling, Gautam Saha, "Principles of Communication", 4th Edition,
		McGraw Hill
	4	Singh & Sapre, Analog & Digital Communication Systems, 3th Edition, McGraw Hill
	5	John G. Proakis,"Communication Systems Engineering 2nd Edition, Pearson Education, 2015
	6	(Schaum's Outline Series) H P HSU & D Mitra, "Analog and Digital Communications", McGraw Hill 3rd Edition
	7	Bernard Sklar, Digital Communications, Pearson Education
	8	Simon Haykin, "Communication Systems", 5th Edition, Wiley India

list of Experiments

	1	Design and Generation of random binary signals		
	2	Study of impairments of signals generated in experiment 1 on passing through a simulated channel by observing Eye Pattern.		
	3	Generation Unipolar NRZ, Polar NRZ, Unipolar RZ and Polar RZ line codes.		
	4	Generation Manchester and AMI line codes		
	5	Conversion of analogue signal into PCM format and its study		
	6	Design and implementation of Delta Modulator for analogue signals		
	7	Design, implementation and study of BASK Modulator and demodulator		
	8	.Design, implementation and study of BPSK Modulator and demodulator		
	9	Design, implementation and study of BFSK Modulator and demodulator		
	10	Design, implementation and study of multiplexer and de-multiplexer of digital signals using TDM.		
	11	study of spread spectrum signal		

Course Title:	Transmission Lines and PCB Technology	Sub code	: 5LP2	5LP26			
		Structure	e: L	T	Р	С	
			0	1	4	3	
Course Objective:	 Learning PCB Fundamentals, Types Learning the design rules for Analog Learning about Transient, AC Swee electronic circuits. Learning about PCB design and man DSB(Double sided Boards). 	, and Classification g, digital and mix p, DC Sweep and nufacturing proce	ons. ed signal electroni operation point si ss flow for SSB (S	c circu mulati Single :	iits. on for v sides bo	various pards) &	
Course Outcome:	 Able to do analysis of various electr Design the Schematics and PCB lay boards). Perform Artwork generation using F Generate various PCB Manufacture 	onic circuits. rout for SSB(Sing 'ilm master equip ing files and dri	gle sides boards) & ment. Il files required f	DSB	Double Bfabric:	sided ation.	
Content			No. of hours	ESI	E Mark	s(%)	

Module 1: Transmission Lines	8	

Introduction to Transmission Lines: Definition and importance of transmission lines, Classification of transmission lines (open-wire, coaxial, microstrip, etc.), Parameters of transmission lines: resistance, inductance, capacitance, and conductance. Basics of Transmission Line Equations: Derivation of Telegrapher's equations. Characteristics of transmission lines: velocity of propagation, characteristic impedance, attenuation constant, and phase constant. RC Transmission Lines: Analysis of RC transmission lines, Determination of characteristic impedance and propagation constant for RC lines, Reflection and transmission coefficients for RC lines. RCC Transmission Lines: Introduction to RCC transmission lines considering resistive, capacitive, and conductive effects, Calculation of characteristic impedance and propagation constant for RCC lines. Infinite Transmission Lines and Control Impedance: Infinite transmission lines: reflectionless lines, matched lines, and quarter-wavelength lines, Design considerations for control impedance, Applications and examples of transmission line designs, Problem-solving sessions and review of key concepts.

20

Module 2: Introduction to PCB Design, tools and techniques	12	30			
Overview of PCB technology and its applications. Introduction to PCB design softw	vare (e.g., Cadence Al	egro / Orcad			
Altium Designer) ,Understanding PCB design considerations: size, shape, layers	, and component placeme	nt ,Basics of			
chematic capture and PCB layout design ,Design rules and constraints for signal integrity, power distribution, and thermal					
management, In-depth exploration of PCB design software features and tools, Pract	tical exercises in schemati	c design and			
PCB layout using industry-standard software ,Advanced techniques for componen	t placement, routing, and	copper pour			
Designing for manufacturability (DFM) and assembly (DFA), Introduction to Design for Testability (DFT) principles.					
Module 3: PCB Manufacturing process	8	20			
	1 1 111 17 1	1' DOD			

Overview of PCB manufacturing processes: substrate selection, imaging, etching, and drilling Understanding PCB fabrication technologies: subtractive, additive, and semi-additive processes ,Quality control and inspection techniques during manufacturing ,Environmental considerations in PCB manufacturing ,Case studies and real-world examples of PCB manufacturing challenges and solutions

Module 4: PCB assembly techniques.	б	20
		1

Introduction to su	irface-m	nount technology (SMT) and through-hole technology (THT) ,Compone	nt selection	on, p	procure	ement,
and inventory m	anagem	ent Soldering techniques: hand soldering, reflow soldering, wave	soldering	PC	B ass	embly
equipment and m	achiner	y: pick-and-place machines, solder paste printers, reflow ovens ,Testin	g and ins	pect	ion me	thods
during PCB asser	nbly: vi	sual inspection, automated optical inspection (AOI), in-circuit testing (ICT)			
Module 5: PCB	6 testing	g and quality assurance	6		1()
Introduction to P	CB test	ing methodologies: functional testing, boundary scan testing, flying pro	be testin	g De	esignir	ig and
implementing tes	t fixture	es and procedures Reliability testing and failure analysis techniques Qu	ality ass	uran	ce star	idards
and certifications	for PC	Bs Continuous improvement strategies in PCB testing and quality mana	gement			
Text/Reference I	Books :					
	1	Printed Circuit Boards: Design and Technology, Walter C Bosshart ,Tata	McGraw-	hill p	publica	tion
	2	Printed Circuit Boards: Design, Fabrication, Assembly & Testing, R S hill publication	Khandpur	,Tata	ı McGr	aw-
	3	Printed Circuit Boards, Coombs Clyde F., Tata McGraw-hill publication				
	4	The Design & Drafting of Analog Printed Circuit boards, Darryl Lindse	y, Bishop	oGraj	phics Ir	ıc
	5	Printed Circuit Boards: Design Techniques For EMC Compliance, Montrose Series of Electronics Technology	Mark I,IE	EEE I	Press	
List of Experime	ents					
	1	Design the current mirror circuit in schematic editor using Autodesk Eagle	e software	and 1	Run the	
		operating point analysis simulation.				
	2	Design the basic diode circuit in schematic editor using Autodesk Eagle sof Transient Analysis simulation.	tware and	Run	the	
	3	Design the basic MOSFET circuit in schematic editor using Autodesk Eagle	e software			
		and Run the DC Sweep Analysis simulation.				
	4	Design the BJT Oscillator circuit in schematic editor using Autodesk Eagle and Run the Transient Analysis simulation.	software			
	5	Create the library component resistor with the followin specifications using Autodesk Eagle software.	ng dim	ensio	ons	and
	6	Create the library component for 555 timer IC with the given dimer specifications using Autodesk EAGLE Software.	isions and	1		
	7	Create the library component for G5LE OMRON RELAY with the given dia and specifications using Autodesk EAGLE Software.	mensions			
	8	Create the library component for NCP716B LDO with the given dimenspecifications Autodesk EAGLE Software.	isions and	đ		
	9	Design the USB TO TTL/CMOS Programmer circuit using FTDI232 schematic editor and draw the PCB layout for the same in Autodes software, run the Electrical Rule Check(ERC) in schematic editor.	2 IC into k EAGLF			
	10	Design the Astable Multivibrator circuit using 555 timer ic into schematic e draw the PCB layout for the same in Autodesk EAGLE software, gener netlist and run design rule check.	ditor and ate BOM	,		
	11	Design the DC TO DC 5V Voltage regulator circuit using LM317 IC into editor and draw the PCB layout for the same in Autodesk EAGLE software gerber files for top electrical and bottom electrical.	schematic , generate	:		

12	To learn the process of generating files(HPGL, ISEL, Excellon) for CNC drilling and milling machine.
13	To learn the process of generating 3D files format and observe the DXF view.
14	Study the various format settings done in photoplotter machine. Learn about artwork generation software, the concept of importing PCB Gerber file and converting files to photoplotter format.
15	To learn the process of generating legends(silkscreen) for Top electrical/ bottom electrical (SSB) Or both (DSB).

Course Title:	Digital Signal Processing	Sub code:	5LP	5LP27				
		Structure:	L	Т	Р	С		
			3	0	2	4		
Course Objective:	Learning about discrete time systems	and to learn al	oout FFT algorit	hms.				
	• Learning the design techniques for FI	R and IIR digi	tal filters.					
	Learning about Realization of Digital	systems.						
Course Outcome:	Understand the principles and technic	ues of digital	signal representa	tion an	d proce	essing.		
	Analyze and design digital filters for	various signal	processing appli	cations	••			
	Gain proficiency in time-domain and	frequency-dor	nain analysis of	discrete	e-time s	signals and		
	Explore advanced topics such as spec	tral analysis, a	daptive filtering	, and m	ultirate	e signal		
	processing.		1 0	, ,		5		
	Develop practical skills in implement	Develop practical skills in implementing signal processing algorithms using software tools and						
	programming languages.			1				
Content]	No. of hours	ESE	Mark	s(%)		
Module 1: Introduction	to discrete time signals and systems		8		20			
Discrete Fourier Transfo	orm, Linear filtering methods based on the DFT, Filter	ering of long s	equences. Direc	t comp	utation	of the DFT,		
Divide and Conquer appr	roach, Radix -2, radix-3 and radix-4 Fast Fourier Trans	sform, Goertzel	l algorithm, Chir	p-z tran	sform,	quantization		
effect in computation of	the DFT.							
Module 2: Implementat	tion of the Discrete time systems		8		2	20		
Structure for the realizat	tion of discrete time FIR and IIR systems, Direct Fo	orm, cascade f	orm, Frequency	sampli	ng stru	cture, lattice		
structure. State space sys	stem analysis and structures. Round-off effects in dig	ital filter.						
Module 3: Design of FI	R Digital Filters		8		2	20		
Magnitude and phase res	sponse of digital filter, frequency response of Linear	phase FIR filte	ers, Design Tech	niques	for FIF	R (Low pass,		
high pass, band pass and	band reject) filters. Design of Optimal Linear phase	FIR Filters, De	esign of Minimu	m phas	e FIR F	Filters.		
Module 4: Design of IIR Digital Filters			8		2	20		
IIR filter design by appro	eximation of derivatives, impulse invariant approach a	nd bilinear tran	sformation. But	erwort	h filters	s, Chebyshev		
filters, Inverse Chebyche	ev filter and elliptic filters, Design of Low pass, hi	igh pass, band	pass and band	reject]	IIR filt	ers. Spectral		
transformation of IIR filt	ters, Effects of Finite word length indigital filters.							
Module 5: Spectral Est	imation methods		8		2	20		
Spectral actimation En	argy Dansity Spactrum Estimation of outcomplet	ion and norm	n spootrum DI	 T incr	octrol c	actimation		
Parameteric and nonpara	metric method for power spectrum estimation	non and powe	a spectrum, Dr	'i insp	ectral e	esumation,		
i diameterie and nonpara	incure method for power speed uni estimation.							

Text/Reference Books :		
	1	Discrete Time Signal Processing, Oppenheim & Schafer, PHI Ltd, Third Edition
	2	Digital Signal Processing: Principles Algorithms and Applications, Proakis Johnand Manolakis.
	3	Digital Signal Processing- A computer based approach, Sanjit K. Mitra, McGrawHill Education.

List of Experiments	
	Compute linear convolution, circular convolution and cross correlation of twosequences.
	2 Verify different properties of Discrete Fourier Transform.
	3 Implement different FFT algorithms.
	Design and implementation of low pass, high pass, band pass and band reject FIRfilters.
	5 Design and implementation of low pass, high pass, band pass and band reject IIR filters of different types.
	5 Computation of power spectral density, correlation function and correlationmatrix of stochastic systems.
	7 Implementation of basic digital signal processes algorithms for differentapplications like demising, edge detection etc. using computer programming.
	3 Implementation of basic digital signal processes algorithms for different applications like denoising, edge detection etc. using digital signal processorslike TMS DSP kits.

Course Title:	Computer Architecture and Organization	Sub code:5L28		5L28		
		Structure:	L	Т	P	С
		I	2	1	0	3
Course Objective:	 This course aims to familiarize students with fundamental coorganization, covering hardware and software aspects such a memory organization, input/output systems, and operating sy Students will gain an overview of the design principles under including topics such as instruction set architecture, processon hierarchy, and input/output interfaces. 	ncepts related to co s CPU architecture, stem functionality. rlying digital compu- or microarchitecture	mputer iting sy	stems ning,	s, mem	ory
	• Through theoretical study and practical exercises, students w represented at the machine level, including binary representa encoding schemes, floating-point representation, and memory them to understand how information is processed within a co	hrough theoretical study and practical exercises, students will learn how data is presented at the machine level, including binary representation of numbers, character neoding schemes, floating-point representation, and memory organization, enabling them to understand how information is processed within a computer system.				
	 Students will gain insight into the execution of computations including arithmetic and logic operations, control flow mech execution cycle, and addressing modes, enabling them to com mechanisms of program execution and data manipulation with 	at the machine leve anisms, instruction nprehend the under thin a computer syst	el, lying tem			
Course Outcome:	• Understand the fundamental principles and components of co including CPU, memory, and I/O devices.	omputer architecture	e			
	• Analyze and design the organization of computer systems at software levels.	both hardware and				
	• Gain proficiency in understanding the instruction set architect implications on system design.	cture (ISA) and its				
	• Explore advanced topics such as pipelining, memory hierarch	hy, and parallel proc	cessing			

	architectures.			
	• Develop practical skills in designing and evaluating compu	ter systems thro	ough	
	simulation, prototyping, and performance analysis.		8	
Content		No. of	ESE Marks (%)	
		hours		
Module 1: Intro	duction of Processor	8	20	
Introduction. Tec	hnologies for building Processors and Memory. Performance. The	e Power Wall.	Operations of the Co	ompute
Hardware. Opera	indo Signed and Unsigned numbers. Representing Instructions. L	ogical Operatio	ons. Instructions for	Makin
Decisions	, , , , , , , , , , , , , , , , , , ,	8 1		
Module 2: Instru	ictions Set	8	20	
MIPS Addressing	g for 32-Bit Immediate and Addresses, Parallelism and Instructions	: Synchronizati	on, Translating and St	arting a
Program, Additio	on and Subtraction, Multiplication, Division, Floating Point, Parall	elism and Con	nputer Arithmetic: Su	ıb wor
Parallelism, Strea	ming SIMD Extensions and Advanced Vector Extensions in x86.		1	
Module 3: Archi	tecture Building Block	8	20	
Logic Design Co	nventions, building a Datapath, A Simple Implementation Scheme.	overview of Pi	pelining, Pipelined D	atapath
Data Hazards: Fo	rwarding versus Stalling, Control Hazards, Exceptions, Parallelism	via Instructions	, The ARM Cortex –	A8 and
Intel Core i7 Pipe	lines, Instruction -Level Parallelism and Matrix Multiply Hardware	Design languag	e.	
Module 4: Memo	ory Mapping	8	20	
Memory Technol	ogies, Basics of Caches, Measuring and Improving Cache Performa	ance, dependab	le memory hierarchy,	Virtua
Machines, Virtua	I Memory, Using FSM to Control a Simple Cache, Parallelism an	d Memory Hie	rarchy: Redundant A	rrays o
Inexpensive Disk	s, Advanced Material: Implementing Cache Controllers.			
Module 5: Memo	ory Management	8	20	
Disk Storage and	Dependability, RAID levels, performance of storage systems. Introd	uction to multi-	threading clusters, me	essage
passing multiproc	ressors.			
Text/Refe	erence Books:			
	1. David A. Patterson and John L. Hennessey, "Computer or	ganization and	design, The	
	Hardware/Software interface", Morgan Kauffman / Elsevier	, Fifth edition,	2014	
	2. V. Carl Hamacher, Zvonko G. Varanesic, and Safat G. Zak	y, "Computer C	Organization", 6 th edi	tion,
	McGraw-Hill Inc, 2012.			
	3. William Stallings, "Computer Organization and Architect	ture", 8th Editi	ion, PearsonEducation	n, 2010
1				
Course title:	Artificial Intelligence and Machine Learning	Sub cod	le: 5LP29	

Course title:	Artificial Intelligence and Machine Learning	Sub code:	SLI	P29		
		Structure:	L	Т	Р	C
			2	0	2	3
Course Objective:	• This course aims to introduce students to fundamental conception artificial intelligence (AI), providing a comprehensive under methodologies.	ts, theories, and adva erstanding of AI prine	anced ciples	techr and	nique	es
	• Students will be introduced to the foundational concepts and p learning, including supervised, unsupervised, and reinforcement to understand the principles behind machine learning and its c	practical applications ant learning algorithm iverse applications.	of m ns, en	achin ablin	e g the	em
	• Through practical examples and case studies, students will lea AI algorithms in diverse fields such as science, medicine, fina	rn how to apply mac nce, and others.	chine	learn	ing a	nd

Course Outcor	ne: • Understand the principles and techniques of artit	icial intelligence and ma	chine learning algorithms.				
	• Analyze and apply supervised, unsupervised, and reinforcement learning techniques to solve						
	engineering problems.						
	• Gain proficiency in designing and implementing	Gain proficiency in designing and implementing machine learning models for pattern recognition,					
	classification, and regression tasks.						
	• Explore advanced topics such as deep learning, neural networks, and natural language processing.						
	• Develop practical skills in programming, data ar	• Develop practical skills in programming, data analysis, and model evaluation using machine					
	learning libraries and frameworks.						
Content		No. of hours	ESE Marks (%)				
Module 1: Introduction to Artificial Intelligence820							
Overview of Ar	tificial Intelligence (AI) and its applications, History and evolu	tion of AI, Foundations	of AI: Logic, reasoning, and				
problem-solving	g, AI techniques: Search algorithms, knowledge representat	ion, and expert systems	Ethical considerations and				
societal impact	of AI						
Module 2: Mad	chine Learning Fundamentals	8	20				
Introduction to	Machine Learning (ML) and its types (supervised, unsupervised to a supervised to a supervised beaming a local data to a supervised beaming a su	ed, reinforcement learnin	ng), Basic concepts: Feature				
support vector t	training, and evaluation, Supervised learning algorithms: Line	ar regression, logistic re-	association rule learning				
Model evaluation	on and validation techniques	isionality reduction, and	association full learning				
Module 3: Dee	en Learning and Neural Networks	8	20				
Introduction to	Deep Learning and neural networks, Basics of artificial r	eurons and activation	functions, Fundamentals of				
feedforward net	ural networks, Training neural networks: Backpropagation alg	orithm, gradient descent	optimization, Deep learning				
Modulo 4: Adv	unad Topics in Machine Learning						
Ensemble learn	ing techniques: Bagging boosting and stacking Support V	ector Machine (SVM) e	vytensions: Kernel methods				
multi-class class	sification. Introduction to reinforcement learning: Markov I	Decision Processes (MD	Ps). O-learning, and policy				
gradients, Intro	duction to natural language processing (NLP): Text preproc	essing, sentiment analys	is, and language modeling,				
Time series ana	lysis and forecasting using machine learning techniques						
Module 5: App	plications of Artificial Intelligence and Machine Learnin	g 8	20				
AI applications	in various domains: Healthcare, finance, robotics, autonomous	vehicles, etc., Case stud	ies and real-world examples				
of AI and ML in	mplementations, Ethical considerations in AI and ML applicat	ions, Future trends and e	emerging technologies in AI				
and ML, Hands	-on projects and practical applications of AI and ML concepts						
Reference Boo	ks:						
	1. Stuart Russell, Peter Norvig, "Artificial Intelligence – A	Modern Approach", Pea	arsonEducation				
	2. Elaine Rich and Kevin Knight, "Artificial Intelligence",	McGraw-Hill					
	3. E Charniak and D McDermott, "Introduction to Artificia	l Intelligence", PearsonH	Education				
	4. Dan W. Patterson, "Artificial Intelligence and Expert Sy	stems", Prentice Hall of	India				
	5. Tom M. Mitchell, —Machine Learning, McGraw-Hill E	ducation (India) Private	Limited,2013.				
	6. Ethem Alpaydin, —Introduction to Machine Learning (A	Adaptive Computation a	ndMachine Learning), The				
	MIT Press 2004.						
Experiments							
	7. Search Algorithm Simulation: Simulate depth-first search a simple maze problem	h and breadth-first searc	h algorithms to solve				
	8. Expert System Development: Create a rule-based expert	system using a decision	tree to diagnose				
	common medical conditions.						
	 Linear Regression Model Implementation: Build a linear based on features like size and number of bedrooms. 	r regression model to pre	edict house prices				
	10. K-Means Clustering Exercise: Apply the k-means cluster distinct groups for targeted marketing strategies.	ring algorithm to segme	nt customer data into				
	11. Convolutional Neural Network (CNN) Training: Train a	CNN model to classify	images of				
	nandwritten digits (MNIST dataset) into their respective	classes.					
	12. Ensemble Learning Experiment: Compare the performan	the of different ensemble	e methods (e.g.,				
	13 Painforcement Learning Simulation: Implement a simulation	a using a Denominark dat	asul.				
13. Reinforcement Learning Simulation: Implement a simple grid-world environment and train an agent							

using Q-learning to navigate and find optimal paths.
14. Sentiment Analysis with NLP: Perform sentiment analysis on movie reviews dataset to classify
reviews as positive or negative using natural language processing techniques.
15. Time Series Forecasting: Use historical stock price data to forecast future prices using time series analysis techniques like ARIMA or LSTM networks.
16. AI and ML Project: Choose a domain of interest (e.g., healthcare, finance) and develop a mini-project applying machine learning techniques to solve a relevant problem, such as disease prediction or stock
price prediction.

Course title:	VLSI Design	Sub co	code: 5LP30				
		Structu	ire:	L	Т	Р	С
				3	0	2	4
 Course Objective: To provide students with a comprehensive understanding of VLSI design fundamentals, covering CMOS logic, fabrication processes, layout representations, design flow, and verification techniques, preparing them for practical VLSI design projects. Students will learn to model MOS transistors, analyze their characteristics, and design CN logic circuits. They will understand the principles behind CMOS logic design, including transistor sizing, noise margin, and static and switching characteristics. Through theoretical study and practical exercises, students will gain proficiency in analyze delay and power characteristics in VLSI circuits. Students will explore various circuit families and design techniques used in VLSI design, including static CMOS, ratioed circuits, dynamic circuits, and pass-transistor circuits. This module aims to familiarize students with subsystem design principles and FPGA technology. 					zMOS yzing n,		
Course Outcome:	 Understand the concepts of Verilog Languag 	ge.					
	 Design the digital systems as an activity in a larger system design context. Study the design and operation of semiconductor memories frequently used in application specific digital system. Inspect how effectively ICs are embedded in package and assembled in PCBsfor different application. Design and diagnosis of processors and I/O controllers used in ambeddedsystems. 					n nt	
Content		No. of l	hours	ESE Marks (%)			
Module 1: Introduct	ion To VLSI		8		2	0	
Basics of VLSI design representations, Stick d packaging and testing,	CMOS Logic: Combinational and sequential circuits, CMC iagrams, Design partitioning, Logic design, Circuit design, Design Flow	DS fabrica Physical	tion and layo design, Desig	outs, Lay gn verifi	out catior	ı, fabrio	cation,
Module 2: MOS and	I CMOS		8		20		
Modelling of MOS tran MOS Transistor Switcl Inverters, Transistor Si Module 3: Delay Pov	sistor, Capacitance voltage characteristics, non-ideal effectes, CMOS Logic design, Circuit and System Representation zing, Static and Switching Characteristics; Body Effect, Noterer	ts DC tran ons, Desig oise Margi	nsfer characte in Equations, in. 8	eristics, M Static L	MOS I oad N	Inverter IOS 20	r,
Image: Constraint Response, RC Delay Model, Effective Resistance, Gate and Diffusion Capacitance, Equivalent RC Circuits, Transient Response, Elmore Delay, Layout Dependence of Capacitance, Determining Effective Resistance, Linear Delay Model Logical Effort Parasitic Delay, Delay in a Logic Gate, Drive, Extracting Logical Effort from Datasheets, Limitations to the Linear Delay Model Logical Effort Parasitic Delay, Delay in a Logic Gate, Drive, Extracting Logical Effort from Datasheets, Limitations to the Linear Delay Model Logical Effort of Paths, Delay in Multistage Logic Networks, Choosing the Best Number of Stages, Sources of power dissipation, dynamic power , static power, Wire Geometry, Example of Metal Stacks, Interconnect Modelling, Resistance, Capacitance Inductance, Skin Effect, Temperature Dependence, Interconnect Impact, Delay, Energy, Crosstalk, Inductive Effects, Module 4: Circuit Design 8 20 Circuit Families, Static CMOS, Ratioed Circuits, Cascode Voltage Switch Logic, Dynamic Circuits, Pass-Transistor Circuits Sequencing Static Circuits, Sequencing Methods, Max Delay Constraints, Min-Delay Constraints, Time Borrowing, Clock Skew Circuit Design of Latches and Flip-Flops, Conventional CMOS Latches, Conventional CMOS Flip-Flops, Pulsed Latches, Resettable Latches and Flip-Flops, Enabled Latches and Flip-Flops, Incorporating Logic into Latches					ansient Effort, Model, pation, citance Sircuits, Skew, settable		
Module 5: Subsystem	n Design FPGA		8			20	
Adders, zero one detectors, comparators, counters, Memory subsystems SRAM, Read and write operation, DRAM, sense amplifiers Field Programmable gate arrays- Logic blocks, routing architecture, design flow technology mapping for FPGAs, Case studies Sitar x XC4000 & ALTERA's FLEX 8000/10000 FPGAs: AT &T ORCA's (Optimized Reconfigurable Cell Array): ACTEL's ACT-1,2,3 and their speed performance							

Reference	e Books:
	 C. Mead and L. Conway, Introduction to VLSI Systems, Addison Wesley,1979. S. M. Kang and Y. Leblebici, CMOS Digital Integrated Circuits : Analysis and Design, Third Edition, MH, 2002 J. M. Rabaey, A. P. Chandrakasan and B. Nikolic, Digital Integrated Circuits : A
	 Design Perspective, Second Edition, PHI /Pearson, 2003. 4. J. P. Uyemura, CMOS Logic Circuit Design, Springer; 2001,. 5. J. P. Uyemura, Introduction to VLSI Circuits and System, Wiley, 2002. 6. R. J. Baker, H. W. Li and D. E. Boyce, CMOS Circuit Design, Layout and Simulation, PH, 1997
List of Experime	ents:
	 Based on VHDL (Xilinx) platform and implementation on FPGA boards: Logic expression s, modulo synchronous and asynchronous up down counters. Multiplexers/ decoders, arithmetic logic unit, priority encoder,62 models based on Moore' s law, mealy model etc. CADENCE CAD tool-based experiments: Design of MOS transistor circuits, DC characteristics, AC small signal analysis and extraction of parameters, design of sample and hold circuits, measurement of switching times, design of PLL and measurement of all characteristics parameters, design of 3-8 decoder using MOS technology.

1

Course title:	SoC Design and Verification	Sub c	Sub code: 6LP31				
		Struc	ture:	L	Т	Р	C
				3	0	2	4
Course Objective: • Understand the fundamentals of System-on-Chip (SoC) design and verification methodo to develop complex integrated circuits. • Gain proficiency in hardware description languages (HDLs) for SoC modeling and simule • Learn advanced techniques for designing and verifying digital and analog components we SoCs, including IP integration and system-level validation. • Explore industry-standard tools and methodologies for SoC design, verification, and test enhancing employability in the semiconductor industry. • Develop practical skills through hands-on projects and case studies, culminating in the d and verification of a custom SoC, preparing students for real-world engineering challeng Course Outcome: • Demonstrate proficiency in designing and verifying complex System-on-Chip (SoC) architectures, adhering to industry standards and best practices. • Acquire hands-on experience in hardware description languages (HDLs) and industry-state tools for SoC medaling circulation					Logies Jation. vithin ting, design ges. tandard		
	 functional correctness and performance optimization. Students will be capable of analyzing and resolving design challenges in SoC projects, considering factors such as power consumption, area utilization, and timing constraints. Prepare students for careers in semiconductor companies, research institutions, or further 					er	
Studies in advanced topics related to SoC design and verification. Content No. of hours ESE Marks (%)					(%)		
Module 1: Introduction to SoC Design			8 20				
Overview of System-on-Chip (SoC) architecture and design methodologies, Introduction to hardware description languages (HDLs such as Verilog and VHDL, SoC design flow and the role of simulation and verification			(HDLs)				
Module 2: Digital Design and Verification820							

Combinational and sequential logic design techniques, Finite State Machine (FSM) design and implementation, RTL (Register Transfer Level) coding using Verilog/VHDL for digital SoC components, Functional verification techniques including testbench development and simulation

Module 3: System Verilog And Universal Verification Methodology	8	20				
Overview of System Verilog as an extension of Verilog with enhanced features for design and verification, Utilizing System Verilog						
for RTL (Register Transfer Level) design of SOC components including modules, interface	es, and hierarchical str	ructures, Introduction				
to UVM as a standardized methodology for verification in System Verilog, Designing mod	lular and reusable ver	ification components				
using the UVM methodology, Developing verification plans to ensure comprehensive ver	fication coverage of	SOC designs.				
Module 4: SoC Integration and Verification820						
IP (Intellectual Property) integration strategies and standards,SoC bus architectures (e.g.,	AMBA) and intercon	nect design, System-				
level verification methodologies including constrained random testing and assertion-base	ed verification, SoC o	lebug techniques and				
tools						
Module 5: Advanced Topics and Project Work 8						
Advanced SoC design concepts such as low-power design techniques and security considerations, Case studies and industry						
applications of SoC design and verification, Group projects involving the design, verification, and testing of a custom SoC,						
Presentation and discussion of project outcomes						

Reference Bo	oks:
	 "Digital Design and Computer Architecture" by David Harris and Sarah Harris "SystemVerilog for Verification: A Guide to Learning the Testbench Language Features" by Chris Spear "Analog Design Essentials" by Willy M. C. Sansen4. J. P. Uyemura, CMOS Logic Circuit Design, Springer; 2001,. "Principles of CMOS VLSI Design: A Systems Perspective" by Neil H. E. Weste and David Harris "System-on-Chip Verification: Methodology and Techniques" by Prakash Rashinkar, et al.
List of Experiments:	
	 Introduction to SoC Design: Experiment 1: FPGA Programming for Basic Logic Circuits. Digital Design and Verification: Experiment 2: Design and Verification of Basic Logic Gates in Verilog. System Verilog and Universal Verification Methodology (UVM): Experiment 3: Introduction to System Verilog Constructs. Experiment 4: Development of a UVM Testbench for SOC Verification. Soc Integration and Verification and Verification of Peripherals in an Soc. Advanced Topics: Experiment 6: Design and Verification of Advanced SoC Components. Project Work: Experiment 7-10: SoC Design Project: Full SoC Development with Peripherals and Advanced Components.

Course title:	Electronic Product Design Using EDA tools	Sub code:	6LP3	32		
		Structure	L	Т	Р	C
			2	0	2	3
Course Objective:	 Develop proficiency in utilizing EDA tool synthesis, and layout design. Enhance design skills to optimize electronic primanufacturability through practical EDA tool 	ls for schemati roducts for perfo applications.	c capt	ture, e, rel	simul	ation, y, and

 Course Outcome: Ability to independently carry out research /investigation and developmentwork to solve pract problems Ability to write and present a substantial technical report/document 				
	 Ability to write and present a substantial technical f Demonstrate a degree of mastery over the area as 	per the specia	lization of	the program. The
	 Inculcate the ability to understand clearly the steps 	in designing ele	propriate b ectronic sy	achelor program stems which are in
	 Create an environment such that graduates develop and be part of the electronic design industry development 	a passion for h to become lea	ardware a ders in ii	nd software design ndigenous product
Content	I	No. of	ESE N	farks (%)
		hours		
Module 1: Introduct	8	20		
Overview of EDA tools Graphics), Basic concep	s for electronic product design, Introduction to popular EDA soft pts of schematic capture, simulation, synthesis, and layout design	ware suites (e.g	., Cadence	e, Synopsys, Mentor
Module 2: Schemati	c Design and Simulation		8	20
Schematic capture tech simulation methodologi integrity through simula	niques using EDA tools, Component selection, placement, and ies (e.g., transient, DC, AC, and transient analysis), Verifying ation.	connectivity c circuit function	onsideratio ality, perfo	ons, Introduction to ormance, and signal
Module 3: Synthesis	and Optimization		8	20
Principles of logic syn techniques for area, pow	thesis and optimization, Utilizing EDA tools for RTL (Register, and timing constraints, Timing analysis and constraints setup	ster Transfer L o for synchrono	evel) synt us digital c	hesis, Optimization lesigns.
Module 4: Layout D	esign and Physical Verification		8	20
Introduction to layout Understanding Design design manufacturabilit	design principles and methodologies, Floor planning, placemer Rule Checks (DRC) and Layout vs. Schematic (LVS) verification y and reliability.	nt, and routing on, Physical ve	technique rification t	s using EDA tools, echniques to ensure
Module 5: Advance	d Topics and Project Work		8	20
Advanced concepts suc complete electronic pro a complex electronic pr	ch as analog/mixed-signal design, power analysis, and formal duct design flow, Hands-on project work involving the design, sin oduct using EDA tools, Presentation and documentation of proje	verification, Int mulation, synthe ct outcomes.	tegration c esis, layou	of EDA tools into a t, and verification of
Reference Books:		.	.	
1. "EDA for IC Louis K. Schef	Implementation, Circuit Design, and Process Technology" by ffer	^v Luciano Lavag	gno, Igor L	. Markov, and
2. "Digital Integ	rated Circuits: A Design Perspective'' by Jan M. Rabaey, Anar	ntha Chandraka	san, and B	orivoje Nikolić
3. "Introduction 4. "SystemVeril	a to VLSI Circuits and Systems" by John P. Uyemura	ter Flake		
5. "ASIC Design Barr	n in the Silicon Sandbox: A Complete Guide to Building Mixe	d-Signal Integ	rated Circ	cuits" by Keith
List of Experiments:				
	1. Schematic Design Exercise:			
	Create a schematic diagram for a simple digital circomponent selection and connectivity	rcuit using EDA	A software,	ensuring proper
	2. Simulation Analysis:			
	 Conduct transient analysis on the designed circuit response using EDA simulation tools. 	to verify its fur	nctionality	and transient
	 3. Logic Synthesis and Optimization Task: Perform RTL synthesis and optimization for a giv and timing constraints. 	en digital desig	n, optimiz	ing for area, power,
	 4. Timing Constraints Setup: Set up timing constraints and perform timing anal 	ysis for synchro	onous digit	al designs to ensure
	5. Layout Design Challenge:	ents.	4 -	
	 Design the layout for the synthesized digital circu routing techniques to optimize layout area and sig 	nal integrity.	100r plann	ing, placement, and

 6. Design Rule Checks (DRC) Evaluation: Conduct DRC checks on the layout design to identify and rectify violations, ensuring compliance with manufacturing rules and constraints.
 7. Layout vs. Schematic (LVS) Verification Task: Perform LVS verification to ensure consistency and accuracy between the schematic and layout designs, resolving any mismatches or discrepancies.
 8. Physical Verification Assignment: Perform physical verification tasks including DRC, LVS, and other checks to ensure design manufacturability and reliability.
 9. Advanced Design Exploration Project: Explore advanced design concepts such as analog/mixed-signal design or power analysis, implementing a small-scale project using EDA tools.
10. Comprehensive Project Presentation:
11. Present and document a comprehensive project involving the entire electronic product design flow, demonstrating proficiency in using EDA tools for design, simulation, synthesis, layout, and verification.

Course Title:	Embedded system and IOT	Sub code:		6LP33			
		Structure:		L	Т	Р	С
				2	1	2	4
Course Objective:	 Leanring the Discipline of Embedded System System Development Learning Basic Embedded Microcontroll Applications. Understanding the Principles of Analysis and Applying IoT Applications to Construct Employed System 	ns and IoT and er Principles d Design for Io bedded Systen	Tts Applica and Practi T Developins of High Q	tion to ces and ment. Quality.	Real-T	ime Em	ibedded
Course Outcome:	 Understand the principles and design metho Analyze and implement real-time operation interfacing for embedded systems. Gain proficiency in designing and develop IoT devices. Explore the integration of IoT technologic healthcare, agriculture, and smart cities. 	dologies of em ing systems, ng embedded es for smart a	bedded syst communica software fo pplications	ems an ition p r contro in vari	d IoT d rotocol olling a ous do	evices. s, and nd mor mains	sensor nitoring such as
	• Develop practical skills in hardware-softw embedded systems and IoT solutions.	are co-design,	system into	egration	n, and	deployi	ment of
Content			No. of hou	irs	ESE	Marks	(%)
Module 1: Introduction	n to Processor Architecture		8			20	
Architecture of Intel processors from 80286 to Pentium-Microarchitectural techniques of advanced processors –pipelining- superscalar concept –Out of order execution –Speculative execution – branch prediction –register renaming -Multicore processors- Processors beyond Pentium- Architecture of ARM Cortex-M – NVIC – WICSleep modes – peripheral programming of a Cortex- M processor.							
Module 2: Robotics De Set	sign And Application Instruction Set And Thum) Instruction	8			20	
Robotics – Designing rob Instruction Set: Data Proc Instructions Thumb Instruction Set: R Load-Store Instructions	otics applications using ARM cortex-M in MSP 432 cessing Instructions, Addressing Modes, Branch, Loc egister Usage, Other Branch Instructions, Data Proc Stack, Software Interrupt Instructions	Robotics kit C ad, Store Instru essing Instruct	GPU Process ctions, PSR ions, Single	sing. Instruc -Regist	etions, (Conditi Multi R	onal Register
Module 3: Communication and Networking in IoT 8 20							

Review of Communication Networks, Challenges in Networking of IoT Nodes, range, bandwidth Machine-to-Machine (M2M) and IoT Technology Fundamentals, Medium Access Control (MAC) Protocols for M2M Communications Standards for the IoT Basics of 5G Cellular Networks and 5G IoT Communications, Low-Power Wide Area networks (LPWAN)Wireless communication for IoT: channel models, power budgets, data rates.Networking and communication aspects: IPv6, 6LoWPAN, COAP, MQTT, Operating Systems need and requirements for IoT..

Module 4: IoT Protocols

Low power, low range protocols –Zigbee –BLE – 6LoWPAN. Applications for IoT-Smart home, city,agriculture etc, - IoT services Project work on Design and development of an IoT product.

8

8

20

20

Module 5: Modern Networking

Cloud computing: Introduction to the Cloud Computing, History of cloud computing, Cloud service options, Cloud Deployment models, Business concerns in the cloud, Hypervisors, Comparison of Cloud providers, Cloud and Fog Ecosystem for IoT Review of architecture IoT Data analytics and Security: OLAP and OLTP, NoSQL databases, Row and column Oriented databases, Introduction to Columnar DBMS CStore, Run :Length and Bit vector Encoding, IoT Data Analytics. Cryptographic algorithms, Analysis of Light weight Cryptographic solutions IoT security, Key exchange using Elliptical Curve Cryptography, Comparative analysis of Cryptographic Library for IoT

Text/Referen	ext/Reference Books :							
	1	Lyla B. Das, The x86 Microprocessors: 8086 to Pentium, Multicores, Atom, and the						
		051 Microcontroller : Architecture ,Programming and Interfacing, Second Edition ,						
		Pearson Education ,India 2014						
	2	Lyla B. Das, Architecture, Programming, and Interfacing of Low-power Processors -						
	ARM7, Cortex-M, Cengage, 2017							
	3	Jan Holler, VlasiosTsiatsis, Catherine Mulligan, Stefan Avesand, Stamatis Karnouskos,						
		David Boyle, From Machine-to-Machine to the Internet of Things: Introduction to a New						
		Age of Intelligence, 1 st Edition, Academic Press, 2014.						
	4	ArshdeepBagha, Vijay Madisetti, Internet of Things, A hands on approach, 2015						
	5	Daniel P. Bovet, Marco Cesati, Understanding the Linux Kernel, 3rd Edition,						
		O'Reilly,2005						
List of Experi	iments	3						
	1	Display Hello WORD message using UART						
	2	Using mobile hotspot network communicate server and Client						
	3	Display Temperature Sensor reading on Putty using UART						
	4	Interface Receiver and transmitter to send data						
	5	Interface LMT86 with ADC to get readings on the UART						
	6	Blink LED using suitable pattern						
	7	Display light intensity on the UART						

Course title:	Computer Network and security	Sub code:	6L34			
		Structure:	L	Т	Р	С
			2	1	0	3

Course Objective:	• This course aims to teach the basic concept of networks like network classification, network topologies network devices.					
	 This course deal with the important concepts and techniques related to data communication and 					
	 This course deal with the important concepts and techniques related to data communication and enable students to have an insight in to technology involved to make the network communication 					
	possible.					
Course Outcome:	• Understand the fundamentals of computer networks, including protocols, architectures, and					
	networking technologies.					
	• Analyze and design network architectures for eff	ficient data transmissi	on, routing, and switching.			
	• Gain proficiency in network security concept	s, including cryptogr	aphy, authentication, and			
	access control.					
	• Explore advanced topics such as wireless network	rks, network managem	ent, and cloud computing.			
	• Develop practical skills in configuring and secu	uring network devices	, conducting vulnerability			
	assessments, and implementing security measur	es to protect against c	yber threats.			
Content		No. of hours	ESE Marks (%)			
Module 1: Introduction		6	14			
Data Communications, Netw	orks, The Internet, Protocols and Standards, Network	Models, Layered Tasl	ks, The OSI Model, Layers			
in the OSI Model, TCP/IP P	rotocol Suite, Addressing, Physical Layer and Media	, Data and Signals, Ar	halog and Digital, Periodic			
Analog Signals, Digital Sign	als, Transmission impairment, Data Rate Limits, Per	formance, Network to	pologies.			
Module 2: Physical and Da	ta Link Layer	8	20			
Bandwidth utilization: Mul	tiplexing and Spreading, Multiplexing, Spread Sp	bectrum, Transmission	n Media, Guided Media,			
Unguided Media: Wireless,	Switching, Circuit-Switched Networks, Datagram Ne	tworks, Virtual-Circu	it Networks, Structure of a			
Switch, Introduction, Block	Coding, Liner Block Codes, Cyclic Codes, Checksu	m, Data Link Control	, Framing, Flow and Error			
Control, Protocols, Noiseles	ss Channels, HDLC, Point-to-Point Protocol, Multip	ble Access, Random A	Access, Aloha, Controlled			
802 11 Bluetooth Connecti	re Landards, Standard Ethernet, Changes III the S	onnecting Devices Ba	ackhone Networks Virtual			
LANs. Sonet Networks. Virt	ual Tributaries. Virtual- Circuit Networks: Frame Re	lav and ATM. Frame	Relay, ATM, ATM LANS,			
			20			
Module 3: Network Layer	and Transport layer	8	20			
Logical Addressing, IPv4 A	ddresses, IPv6 Addresses, Network Layer: Internet P	rotocol, Internetworki	ng, IPv4, IPv6, Transition			
from IPv4 to IPv6, Networ	k Layer: Address Mapping, Error Reporting and N	Multicasting, Address	Mapping, ICMP, IGMP,			
ICMPv6, Network Layer: De	elivery, Forwarding and Routing, Delivery, Forwardir	ng, Unicast Routing Pr	otocols, Multicast Routing			
Protocols. Process-Process I	Delivery: UDP, TCP and SCTP, Process-to-Process I ad Quality of Service, Data Traffic, Congression, Cong	Delivery, User Datagr	am Protocol (UDP), TCP,			
Techniques to improve OoS	Integrated Services, Differentiated Services, OoS in	Switched Networks	sxamples, Quanty Service,			
Module 4: Application Lay	er	6	16			
Domain Name System, Name Massagas, Typos of Pacords	Space, Domain Name Space, Distribution of Name Space, Dynamic Domain Name System (DDNS)	Space, DNS in the Inte	rnet, Resolution, DNS			
Mail and File Transfer. Remo	te Logging, Telnet, Electronic Mail, File Transfer, W	WW and HTTP: Arch	itecture. Web Documents.			
HTTP, Network Management	: SNMP, Network Management System, Simple Netw	work Management Pro	otocol (SNMP),			
Multimedia, Digitizing Audio	and Video, Audio and Video Compression, Streamin	ng Stored Audio/Video	o, Streaming Live			
Audio/Video, Real-Time Inter	ractive Audio/Video, RTP, RTCP, Voice over IP.					
Module 5: Network Securit	ty	6	14			
Security concepts and termino	ology TCP/IP and OSI network security access contro	l issues (packet filters	, firewalls) communication			
security (OSI layer security pi and its application	cotocols) security tools cryptography- Public Key Cry	ptography And Its Ap	plication, Cyber Security			
Modulo (; Winsloss Conson)	Notero ela	6	16			
iviouule o: wireless Sensor f		0				
Introduction to Wireless Sensor Sensor Networks, Energy-Eff	or Networks, Sensor Node Architecture and Characte icient Protocols and Algorithms, Applications and Ch	ristics, Communication nallenges of Wireless S	n Protocols for Wireless Sensor Networks			
Reference Books:						

1. Data Communications and Networking, Fourth Edition by Behrouza A. Forouzan, TMH.
2. Computer Networks, A.S. Tanenbaum, 4th edition, Pearson education.
3. Introduction to Data communications and Networking, W. Tomasi, Pearsoneducation.
4. Data and Computer Communications, G.S. Hura and M. Singhal, CRC Press, Taylor
and Francis Group.
5. An Engineering Approach to Computer Networks-S. Keshav, 2nd Edition, Pearson
Education
6. Understanding communications and Networks, 3rd Edition, W. A. Shay, Cengage
Learning.
7. "Modern Cryptography, Theory & Practice", Pearson Education. Wenbo Mao
8. "Computer Security", Pearson Education. Matt Bishop

Course title:	ADVANCE COMMUNICATION	Sub code:			6L36		
		Structure:	L	Т	Р	С	
			3	0	0	3	
Course Objective:	• To provide students with an understanding of satel orbit types, transmission theory, system noise para network architectures, enabling them to design and effectively.	llite communication s meters, link design, s d analyze satellite con	ystem ubsys nmun	ns, inc stems, icatio	ludin and ` n syst	g various VSAT eems	
	• Students will learn about optical fiber types, signa optical sources, detectors, link design principles, or technologies, empowering them to design and anal networks.	l degradation factors, optical switches, nonlin lyze optical communi	fabric near e catior	cation effects 1 syste	techr s, and ems a	niques, amplifier nd	
	• Through theoretical study and practical examples, fundamentals, signal processing techniques, and a synthetic aperture radar (SAR), moving target indi them to analyze and design radar systems for vario	students will gain pro pplications such as pu ication (MTI), and ada ous applications.	oficier lse-D aptive	ncy in opple radai	rada r rada :, enal	r system ar, bling	
	• Students will understand the evolution of mobile communication from 1G to 5G, including analog and digital voice systems, GSM, CDMA, 3G, 4G, and LTE technologies. They will learn about the architecture, protocols, data rates, and enhancements in each generation, along with an introduction to 5G networks and technologies such as SDN, NFV, MEC, and network slicing.						
	• This module aims to familiarize students with mic electromagnetic wave propagation phenomena. The modes, fading effects, microwave system architect them to design and analyze microwave communic	rowave communication ney will learn about di tures, and digital micr ation links effectively	on sys fferer owav	stems nt proj e syst	and pagat ems,	ion enabling	
Course Outcome:	 Understand the orbital and functional principles of satellite communicationsystems. Architect, interpret, and select appropriate technologies for implementation ofspecified satellite communication systems. 						
	 Analyse and evaluate a satellite link and suggest enhancements to improve the link performance. 						
	• Select an appropriate modulation, multiplexing, coding and multiple accessschemes for a given satellite communication link.						
	• Specify, design, prototype and test communication systems as per given specification	analogue and s.	di	gital	sat	tellite	
Content		No. of hours	ES	SE Ma	arks ((%)	
Module 1: Basics of	Satellite theory and it's application	8	20				

Introduction: Overview of Satellite Communications, GEO, MEO and LEO satellite systems, frequency bands, Kepler's Law. Basic transmission theory, types of satellite and its uses System noise temperature and G/T ratio, CNR, CIR, ACI, IMI, Down link design, Up link design, System design examples. Attitude and Orbit Control System (AOCS), Telemetry, Tracking and Command System (TT&C), Power System, Satellite antennas, Communications subsystem, transponders. Overview of VSAT systems, Network architectures, Access control, Multiple access selection. Orbits, Coverage and frequency bands, off axis scanning, delay and throughput, NGSO constellationdesign

20

Different types of optical fibre ,Modal analysis of a step index fibre . Signal degradation on optical fiber due to dispersion and attenuation. Fabrication of fibers and measurement techniques like OTDR. Optical sources - LEDs and Lasers, Photo-detectors - pin-detectors, detector responsivity, noise, optical receivers. Optical link design - BER calculation, quantum limit, power penalties. Optical switches - coupled mode analysis of directional couplers, electro-optic switches. Nonlinear effects in fiber optic links. Concept of self-phase modulation, group velocity dispersion and solition based communication. Optical amplifiers - EDFA, Raman amplifier, Coherent communication and WDM systems.

Module 3: Radar theory and its applications	8	20

The Radar System, the radar range equation, scattering and RCS, RCS models, propagation, antennas, receivers, noise figure. Radar Signal Processing Fundamentals, detection and likelihood ratio. Applications of Radar Signal Processing: Pulse-Doppler radar, CFAR detection, synthetic aperture radar (SAR), inverse synthetic aperture radar (ISAR), moving target indication (MTI), displaced-phase-center-antenna technique (DPCA), adaptive radar, super resolution (MUSIC), space-time adaptive processing (STAP)

Module 4: Mobile communication 8	20
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Evolution from 1G to 5G, Analog voice systems in 1G, digital radio systems in 2G, voice and messaging services, TDMA based GSM, CDMA, 2.5G (GPRS), 2.75G (EDGE); IMT2000, 3G UMTS, W-CDMA, HSPA, HSPA+, 3G services and data rates, IMT Advanced, 4G, LTE, VoLTE, OFDM, MIMO, LTE Advanced Pro (3GPP Release 13+), IMT2020, enhancements in comparison to IMT Advanced

5G network: Data Adaptation Protocol (SDAP), centralized RAN, open RAN, multi-access edge computing (MEC); Introduction to software defined networking (SDN), network function virtualization (NFV), network slicing; restful API for service-based interface, private networks.

Module 5: Microwave theory and EM Wave propagation	8	20				
Block diagram of terrestrial communication, EM wave frequency and its application ,advantage of microwave system, properties.						
EM wave propagation- ground wave or surface wave sky wave/ionospheric wave, space wave, duct wave propagation, Fading,						
microwave communication system, LOS microwave system, digital microwave system, block diagram of digital microwave						
system						

Reference	ce Books:
	 Satellite communication, "Timothy Pratt, Charles Bostian, Jeremy Allnut", JohnWilley and Sons Inc, 2nd edition. Satellite Communication Technology, Dr. K. Miya, 2nd edition. G. D. Gordon and W. L. Morgan, "Communications Satellite Handbook," WileyIndia, 2010 "Fibre Optic Communications" by Harold B Killen "Fibre Optic Communication" by Agarwal D C F.E. Terman, Radio Engineering, McGraw Hill Book Co. (for Chapter 7 only),Fourth Edition 1955 Simon Kingsley & Shaun Quegan, Understanding RADAR Systems, McGraw HillBook Co., 1993 Telecommunication Transmission Systems Microwave, Fiber Optic, Mobile Cellular Radio, Data, And Digital Multiplexing By <u>Robert Winch</u>

Course title:	Dissertation Phase-II	Sub code:	8P43	8P43			
		Structure:	L	Т	Р	С	
			0	0	40	20	
Course Objective:	Final Year Projects represent the culmination of study towards the Bachelor of Engineering degree. Projects offer the opportunity to apply and extend material learned throughout the program. Assessment is by means of a seminarpresentation, submission of a thesis, and a public demonstration of work undertaken. The projects undertaken span a diverse range of topics, including theoretical, simulation and experimental studies. The emphasis is necessarily on facilitating student learning in technical, project management and presentation spheres.						
Course outcome:	 Apply knowledge and skills acquired throughout the program to solve real-world engineering problems. Gain hands-on experience in designing, implementing, and testing innovative engineering solutions. Develop project management skills including planning, scheduling, and resource allocation. Enhance communication and presentation skills through the documentation and presentation of project outcomes. Prepare for transition into the workforce or further academic pursuits by demonstrating competency in project is a larger of a batteril preparied. 						
Content		No. of hours	ESE M	arks	(%)		
Module 1: Term Wo	ork	1	<u> </u>				
Dissertation Phase-II, is in continuation of Project Part-I undertaken by the candidates in first term. The term workshall consist of						onsist of	
a typed report of about 70 pages or more, on the work carried out by the batch of students inrespect of the project assigned, during first term and second term. It should be in the proper format.							
Module 2: Practical Examination:							
It shall consist of demonstration of designed, fabricated project and oral based on it. The said examination will be conducted by					ted by		
a panel of two examiners; one of them will be a guide and another will be an external examiner. The external examiner will be							

either from the allied industry or a senior faculty member from another institute.